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Revision History:

Revision	Date	Description	
0.01	2013/12/10	1 st version	
0.02	2014/02/10	Add section 5.10.3 Notice for LVR reset ,Add chapter 8 Special Notes	
0.03	2014/12/22	Amend PMS156 operating temperature to -40°C ~ 85°C	
0.04	2015/06/16	Amend PMS156 operating temperature to -20°C ~ 70°C	
0.05	2016/07/07	1. Add section 5.8.3: the description of wake-up	
0.05	2010/07/07	2. Add section 8.3 Warning	
		1. Add company address & Tel No.	
		2. Amend Section 1.1, 1.2, 1.3	
		3. Add Section 1.4: Package Information	
		4. Add Chapter 3 Pin Assignment and Description: PMC156-S08, PMC156-D08,	
		PMS156-S08, PMS156-D08	
		5. Amend Section 4.1 DC/AC Characteristics	
		6. Amend Section 4.3 to 4.14	
		7. Add 4.16:Typical power down current (I_{PD}) and power save current (I_{PS})	
		8. Add Section 5.2.1 Timing charts for reset conditions	
		9. Amend Table2: Three Oscillator Circuits provided by PMC156/PMS156	
		10. Amend Section 5.4.1, 5.4.3, 5.4.4, 5.4.5	
		11. Amend Section 5.5 16-bit Timer	
1.06	2018/12/12	12. Amend Section 5.7 Interrupt	
		13. Amend Section 5.8.1, 5.8.2, 5.8.3	
		14. Amend Section 5.10.2, 5.10.3	
		15. Amend Section 5.11 LCD Bias Voltage Generator	
		16. Amend Section 6.6, 6.10, 6.11, 6.18	
		17. Delete the Symbol "pc0" in Chapter 7	
		18. Amend Section 7.8 Summary of Instructions Execution Cycle and delete 8.1.7	
		19. Move Section 8.1.8 BIT definition to Section 7.10	
		20. Add Chapter 8 Code Options	
		21. Move Section 8.3 to Section 9.1 and updated the link	
		22. Amend Section 9.2.1, 9.2.5, 9.2.9	
		23. Add Section 9.2.7 IHRC	
		24. Amend Section 9.3 Using ICE	



1. Features

1.1. Special Features

- PMC156 series:
 - ♦ High EFT series
 - ♦ Operating temperature range: -40°C ~ 85°C
- PMS156 series:
 - ♦ General purpose series
 - Not supposed to use in AC RC step-down powered or high EFT requirement applications.
 PADAUK assumes no liability if such kind of applications can not pass the safety regulation tests.
 - ♦ Operating temperature range: -20°C ~ 70°C

1.2. System Features

- 1KW OTP program memory
- 64 Bytes data RAM
- One hardware 16-bit timer
- Support fast wake-up
- 16 IO pins with 10mA capability and optional pull-high resistor
- Every IO pin can be configured to enable wake-up function
- Band-gap circuit to provide 1.20V reference voltage
- Built-in half VDD bias voltage generator for LCD application
- Built-in Internal High RC Oscillator (IHRC)
- Operating frequency range:
 - DC ~ 8MHz@V_{DD} $\!\!\geq$ 3.3V; DC ~ 4MHz@V_{DD} $\!\!\geq$ 2.5V; DC ~ 2MHz@V_{DD} \!\!\geq 2.2V
- Operating voltage range: 2.2V ~ 5.5V
- ◆ Low power consumption
 I_{operating} ~ 1.7mA@1MIPS, V_{DD}=5.0V
 I_{powerdown} ~ 1uA@V_{DD}=5.0V
 I_{powerdown} ~ 0.5uA@V_{DD}=3.3V
- Clock sources: External crystal oscillator, internal high RC oscillator and internal low RC oscillator
- Eight levels of LVR reset : 4.1V, 3.6V, 3.1V, 2.8V, 2.5V, 2.2V, 2.0V, 1.8V
- Two external interrupt pins

1.3. CPU Features

- One processing unit operating mode
- ◆ 79 Powerful instructions
- Most instructions are 1T execution cycle
- Programmable stack pointer and adjustable stack level
- Direct and indirect addressing modes for data access. Data memories are available for use as an index pointer of Indirect addressing mode
- IO space and memory space are independent



1.4. Package Information

PMC156 Series

- ♦ PMC156-S20: SOP20 (300mil);
- ♦ PMC156-S18: SOP18 (300mil);
- ♦ PMC156-D18: DIP18 (300mil);
- ♦ PMC156-S16: SOP16 (150mil);
- ♦ PMC156-S14: SOP14 (150mil);
- ♦ PMC156-S08: SOP8 (150ml);
- ♦ PMC156-D08: DIP8 (300mil)

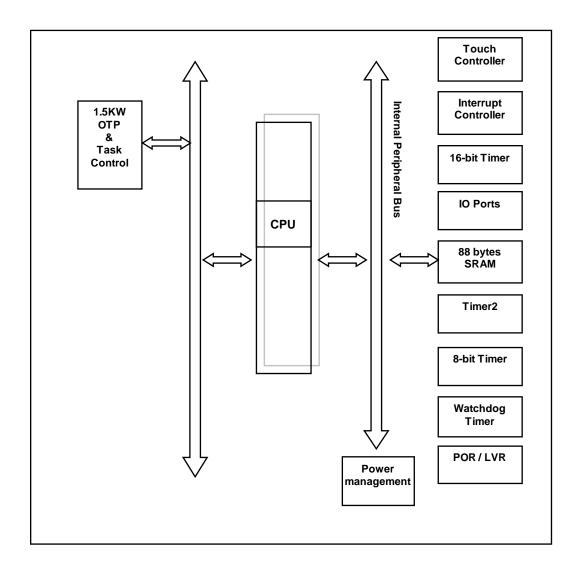
PMS156 Series

- ♦ PMS156-S20: SOP20 (300mil);
- ♦ PMS156-S18: SOP18 (300mil);
- ♦ PMS156-D18: DIP18 (300mil);
- ♦ PMS156-S16: SOP16 (150mil);
- ♦ PMS156-S14: SOP14 (150mil);
- ♦ PMS156-S08: SOP8 (150ml);
- ♦ PMS156-D08: DIP8 (300mil)



2. General Description and Block Diagram

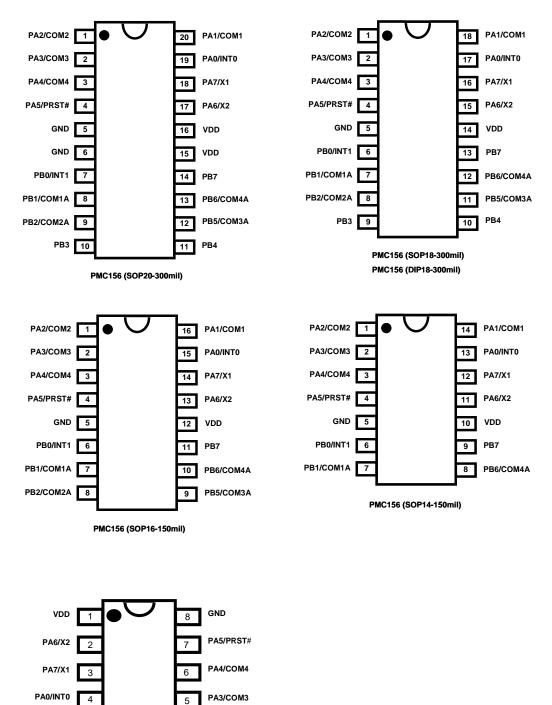
The PMC156/PMS156 is an IO-Type, OTP-based CMOS 8-bit microcontroller. The PMC156/PMS156 employs RISC architecture and most the instructions are executed in one cycle except that few instructions are two cycles that handle indirect memory access. 1KW bits OTP program memory and 64 bytes data SRAM are inside, one hardware 16-bit timer is also provided in the PMC156/PMS156.





3. Pin Assignment and Functional Description

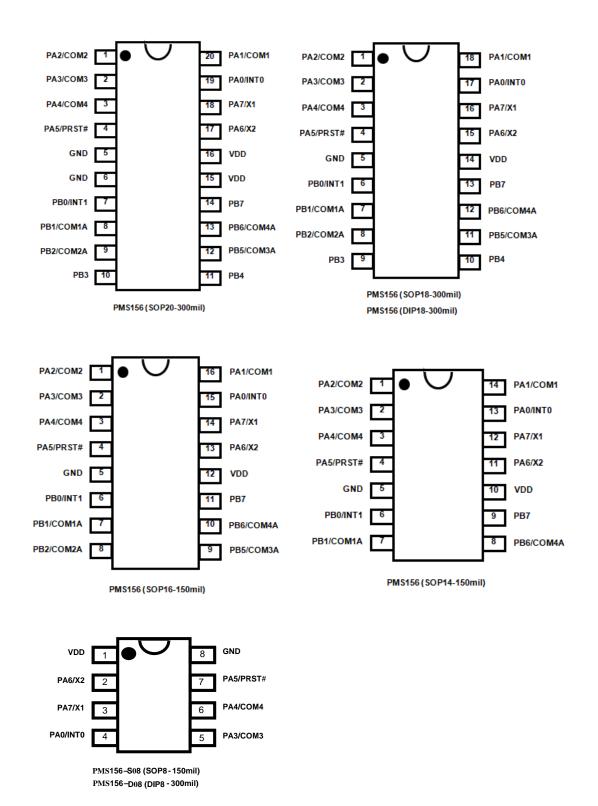
PMC156 series



PMC156-S08 (SOP8-150mil) PMC156-D08 (DIP8-300mil)



PMS156 series





Pin Name	Pin & Buffer Type	Description
PA7/ X1	IO ST / CMOS / Analog	 The functions of this pin can be: (1) Bit 7 of port A. It can be configured as digital input or two-state output, with pull-high resistor. (2) X1 (input) when crystal oscillator is used. If this pin is used for crystal oscillator, bit 7 of <i>padier</i> register must be programmed "0" to avoid leakage current. This pin can be used to wake-up system during sleep mode; however, wake-up function is also disabled if bit 7 of <i>padier</i> register is "0".
PA6/ X2	IO ST / CMOS / Analog	 The functions of this pin can be: (1) Bit 6 of port A. It can be configured as digital input or two-state output, with pull-high resistor. (2) X2 (output) when crystal oscillator is used. If this pin is used for crystal oscillator, bit 6 of <i>padier</i> register must be programmed "0" to avoid leakage current. This pin can be used to wake-up system during sleep mode; however, wake-up function is also disabled if bit 6 of <i>padier</i> register is "0".
PA5/ PRST#	IO ST / CMOS	 The functions of this pin can be: (1) Bit 5 of port A. It can be configured as digital input or open-drain output pin. <u>Please notice that there is no pull-high resistor in this pin.</u> (2) Hardware reset. This pin can be used to wake-up system during sleep mode; however, wake-up function is also disabled if bit 5 of <i>padier</i> register is "0". <u>Please put 33Ω resistor in series to have high noise immunity when this pin is in input mode.</u>
PA4 / COM4	IO ST / CMOS / Analog	 The functions of this pin can be: (1) Bit 4 of port A. It can be configured as digital input or two-state output, with pull-high resistor. (2) COM4 of group 1 for LCD to provide (1/2 VDD) for LCD bias voltage. (3) Channel 0 input. This pin can be used to wake up system during sleep mode; however, wake-up function from this pin is also disabled when bit 4 of <i>padier</i> register is "0"
PA3 / COM3	IO ST / CMOS / Analog	 The functions of this pin can be: (1) Bit 3 of port A. It can be configured as digital input or two-state output, with pull-high resistor. (2) COM3 of group 1 for LCD to provide (1/2 VDD) for LCD bias voltage. This pin can be used to wake up system during sleep mode; however, wake-up function from this pin is also disabled when bit 3 of <i>padier</i> register is "0"
PA2 / COM2	IO ST / CMOS / Analog	 The functions of this pin can be: (1) Bit 2 of port A. It can be configured as digital input or two-state output, with pull-high resistor. (2) COM2 of group 1 for LCD to provide (1/2 VDD) for LCD bias voltage. This pin can be used to wake up system during sleep mode; however, wake-up function from this pin is also disabled when bit 2 of <i>padier</i> register is "0"



Pin Name	Pin Type & Buffer Type	Description
PA1 / COM1	IO ST / CMOS / Analog	 The functions of this pin can be: (1) Bit 1 of port A. It can be configured as digital input or two-state output, with pull-high resistor. (2) COM1 of group 1 for LCD to provide (1/2 VDD) for LCD bias voltage. This pin can be used to wake up system during sleep mode; however, wake-up function from this pin is also disabled when bit 1 of <i>padier</i> register is "0"
PA0 / IO ST / INT0 CMOS / Analog		 The functions of this pin can be: (1) Bit 0 of port A. It can be configured as digital input or two-state output, with pull-high resistor. (2) External interrupt line 0. <u>Both rising edge and falling edge are accepted to request interrupt service</u>. This pin can be used to wake up system during sleep mode; however, wake-up function from this pin is also disabled when bit 0 of <i>padier</i> register is "0".
PB7	IO ST / CMOS / Analog	 The functions of this pin can be: (1) Bit 7 of port B. It can be configured as digital input or two-state output, with pull-high resistor. This pin can be used to wake up system during sleep mode; however, wake-up function from this pin is also disabled when bit 7 of <i>pbdier</i> register is "0".
PB6 / IO COM4A CMOS		 The functions of this pin can be: (1) Bit 6 of port B. It can be configured as digital input or two-state output, with pull-high resistor. (2) COM4A of group 2 for LCD to provide (<u>1/2 VDD</u>) for LCD bias voltage. This pin can be used to wake up system during sleep mode; however, wake-up function from this pin is also disabled when bit 6 of <i>pbdier</i> register is "0".
PB5 / COM3A	IO ST / CMOS	 The functions of this pin can be: (1) Bit 5 of port B. It can be configured as digital input or two-state output, with pull-high resistor. (2) COM3A of group 2 for LCD to provide (1/2 VDD) for LCD bias voltage. This pin can be used to wake up system during sleep mode; however, wake-up function from this pin is also disabled when bit 5 of <i>pbdier</i> register is "0".
PB4	IO ST / CMOS	 The functions of this pin can be: (1) Bit 4 of port B. It can be configured as digital input or two-state output, with pull-high resistor. This pin can be used to wake up system during sleep mode; however, wake-up function from this pin is also disabled when bit 4 of <i>pbdier</i> register is "0".
PB3	IO ST / CMOS	The functions of this pin can be bit 4 of port B. It can be configured as digital input or two-state output, with pull-high resistor. This pin can be used to wake up system during sleep mode; however, wake-up function from this pin is also disabled when bit 3 of pbdier register is "0".



Pin Name	Pin Type & Buffer Type	Description
PB2 / COM2A	IO ST / CMOS	 The functions of this pin can be: (1) Bit 2 of port B. It can be configured as digital input or two-state output, with pull-high resistor. (2) COM2A of group 2 for LCD to provide (1/2 VDD) for_LCD bias voltage. This pin can be used to wake up system during sleep mode; however, wake-up function from this pin is also disabled when bit 2 of <i>pbdier</i> register is "0".
PB1 / COM1AIO ST / CMOSThe functions of this pin can be: (1) Bit 1 of port B. It can be configured as digital in pull-high resistor. (2) COM1A of group 2 for LCD to provide (1/2 VD) This pin can be used to wake up system during sleep		(1) Bit 1 of port B. It can be configured as digital input or two-state output, with
PB0 / IO ST / INT1 CMOS		 The functions of this pin can be: (1) Bit 0 of port B. It can be configured as digital input or two-state output, with pull-high resistor. (2) External interrupt line 1. Both rising edge and falling edge are accepted to request interrupt service. This pin can be used to wake up system during sleep mode; however, wake-up function from this pin is also disabled when bit 0 of <i>pbdier</i> register is "0".
VDD		Positive power
GND	Ground	
Notes: IO: Input/0	Dutput; ST : Sch	mitt Trigger input; Analog: Analog input pin; CMOS: CMOS voltage level



4. Device Characteristics

4.1. DC/AC Characteristics

All data are acquired under the conditions of V_{DD}=5.0V, f_{SYS}=2MHz unless noted.

Symbol	Description	Min	Тур	Max	Unit	Conditions
V _{DD}	Operating Voltage	2.2	5.0	5.5	V	* Subject to LVR tolerance
	System clock* =					Under_20ms_Vdd_ok**= Y/N
	IHRC/2	0		8M		$V_{DD} {\geqq} 2.5 V / V_{DD} {\geqq} 3.1 V$
f _{SYS}	IHRC/4	0		4M	Hz	$V_{DD} {\triangleq} 2.2 V / V_{DD} {\triangleq} 2.5 V$
	IHRC/8	0		2M		$V_{DD} {\triangleq} 2.2 V / V_{DD} {\triangleq} 2.2 V$
	ILRC		37K			$V_{DD} = 5.0V$
	Operating Current		1.7		mA	f _{SYS} =1MIPS@5.0V
I _{OP}	Operating Current		8		uA	f _{SYS} =ILRC=21kHz@3.3V
	Power Down Current		1		uA	$f_{SYS} = 0Hz, V_{DD} = 5.0V$
I _{PD}	(by stopsy s command)		0.5		uA	f_{SYS} = 0Hz,V _{DD} =3.3V
	Power Sove Current					V _{DD} =5.0V;
I _{PS}	Power Save Current		0.4		mA	Band-gap, LVR, IHRC, ILRC,
	(by <i>stopexe</i> command)					Timer16 modules are ON.
V _{IL}	Input low voltage for IO lines	0		$0.3 V_{\text{DD}}$	V	
V _{IH}	Input high voltage for IO lines	$0.7 V_{DD}$		V _{DD}	V	
I _{OL}	IO lines sink current	7	10	13	mA	V_{DD} =5.0V, V_{OL} =0.5V
I _{OH}	IO lines drive current	-5	-7	-9	mA	V _{DD} =5.0V, V _{OH} =4.5V
I _{INJ (PIN)}	Injected current on pin			1	mA	V_{DD} +0.3 \geq V _{IN} \geq -0.3
			62			V _{DD} =5.0V
R _{PH}	Pull-high Resistance		100		KΩ	V _{DD} =3.3V
			210			V _{DD} =2.2V
		3.86	4.15	4.44		
		3.35	3.60	3.85		
		2.84	3.05	3.26		
V	Low Voltage Reset Voltage *	2.61	2.80	3.00	V	
V _{LVR}	Low voltage Reset voltage	2.37	2.55	2.73	v	
		2.04	2.20	2.35		
		1.86	2.00	2.14		
		1.67	1.80	1.93		
		15.84*	16*	16.16*		@25°C
f	Frequency of IHRC after				MHz	V _{DD} =2.2V~5.5V,
f _{IHRC}	calibration *	15.20*	16*	16.80*	IVITIZ	-40°C <ta<85°c*< td=""></ta<85°c*<>
		15.28*	16*	16.72		-20°C <ta<70°c*< td=""></ta<70°c*<>



Symbol	Description	Min	Тур	Мах	Unit	Conditions
		31.3*	37*	41.9*		V _{DD} =5.0V, Ta=25°C
		24.0*	37*	50.0*		V _{DD} =5.0V, -40°C <ta<85°c*< td=""></ta<85°c*<>
4		25.9*	37*	48.1*		V _{DD} =5.0V, -20°C <ta<70°c*< td=""></ta<70°c*<>
f _{ILRC}	Frequency of ILRC *	18.3*	21*	24.5*	KHz	V _{DD} =3.3V, Ta=25°C
		14.0*	21*	29.0*		V _{DD} =3.3V, -40°C <ta<85°c*< td=""></ta<85°c*<>
		14.7*	21*	27.3*		V _{DD} =3.3V, -20°C <ta<70°c*< td=""></ta<70°c*<>
t _{INT}	Interrupt pulse width	30			ns	$V_{DD} = 5.0 V$
V _{DR}	RAM data retention voltage*	1.5			V	In power-down mode.
			2048		ILRC	misc[1:0]=00 (default)
t _{WDT}	Watchdog timeout period		4096		clock period	misc[1:0]=01
			16384			misc[1:0]=10
	System boot-up period from		29		m 0	@V _{DD} =5V, ILRC~37kHz
t _{SBP}	power-on		48		ms	@V _{DD} =3.3V, ILRC~21kHz
	System wake-up period					
	Fast wake-up by IO toggle from STOPEXE suspend		128		T _{SYS}	Where T _{SYS} is the time period of system clock
	Fast wake-up by IO toggle from		128 T _{SYS}			Where T is the stable
t _{WUP}	STOPSYS suspend, IHRC is the		+			Where T _{SIHRC} is the stable time of IHRC from power-on.
	system clock		T _{SIHRC}			
	Normal wake-up from					Where T _{ILRC} is the clock
	STOPEXE or STOPSYS		1024		T _{ILRC}	period of ILRC
	suspend					
t _{RST}	External reset pulse width	120			us	@V _{DD} =5V

*These parameters are for design reference, not tested for every chip.

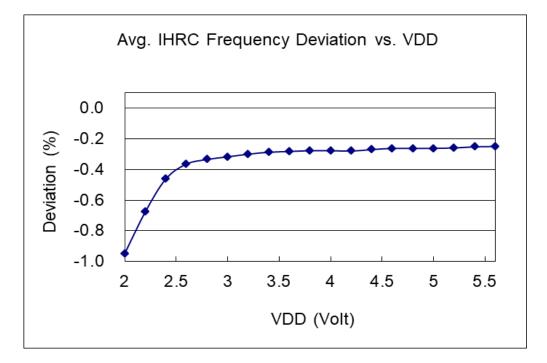
** Under_20ms_Vdd_Ok is a checking condition for the VDD rising from 0V to the stated voltage within 20ms.

4.2. Absolute Maximum Ratings

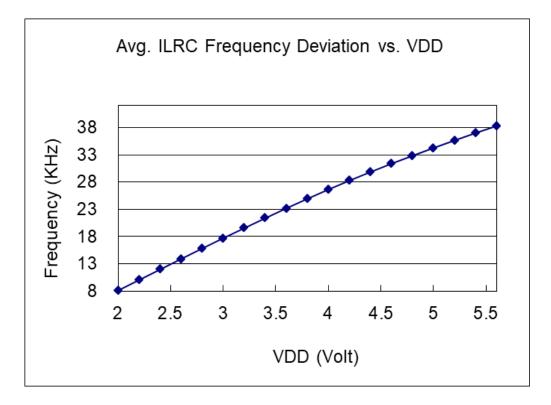
•	Supply Voltage	2.2V ~ 5.5V
•	Input Voltage	$-0.3V \sim V_{DD} + 0.3V$
•	Operating Temperature	PMC156 series:-40°C ~ 85°C
		PMS156 series:-20°C ~ 70°C
•	Storage Temperature	-50°C ~ 125°C
•	Junction Temperature	150°C



4.3. Typical IHRC Frequency vs. VDD (calibrated to 16MHz)

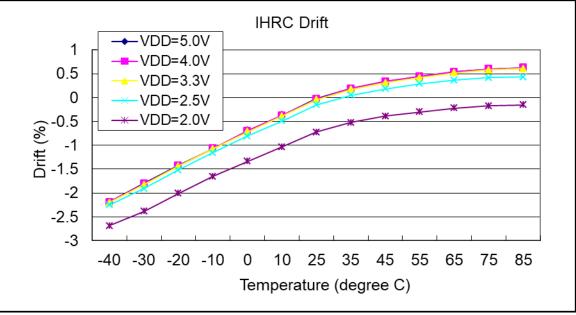


4.4. Typical ILRC Frequency vs. VDD



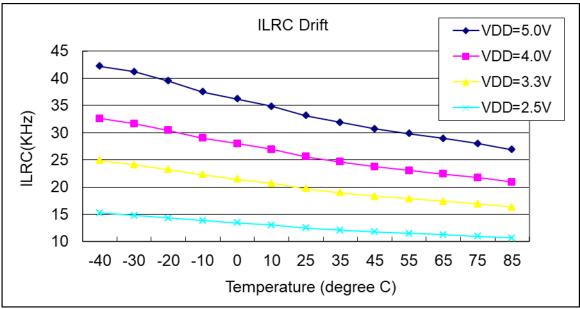


4.5. Typical IHRC Frequency vs. Temperature (calibrated to 16MHz)



^{*} PMS156 series:-20°C ~ 70°C

4.6. Typical ILRC Frequency vs. Temperature



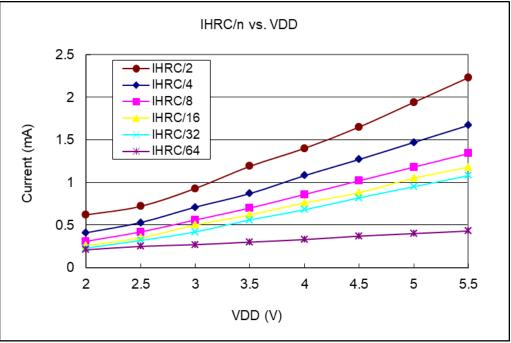
* PMS156 series:-20°C ~ 70°C



4.7. Typical Operating Current vs. VDD and CLK=IHRC/n

Conditions:

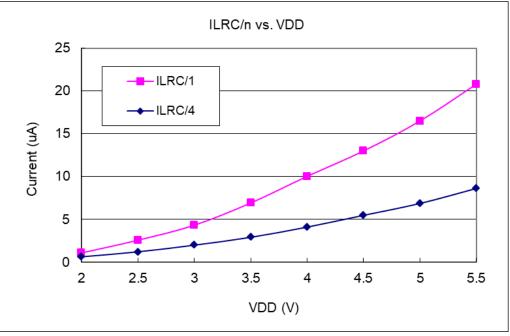
ON: Band-gap, LVR, IHRC, T16 modules; **OFF**: ILRC, EOSC modules; **IO**: PA0:0.5Hz output toggle and no loading, others: input and no floating



4.8. Typical Operating Current vs. VDD and CLK=ILRC/n

Conditions:

ON: Band-gap, LVR, ILRC, T16 modules; **OFF**: IHRC, EOSC modules; **IO**: PA0:0.5Hz output toggle and no loading, others: input and no floating

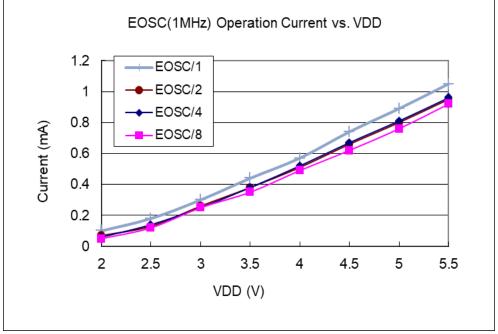




4.9. Typical Lowest Operating Current vs. VDD and CLK=ILRC/n

Conditions:

ON: ILRC, T16 module; **OFF**: IHRC, EOSC, Band-gap, LVR modules; **IO**: PA0:0.5Hz output toggle and no loading, others: input and no floating



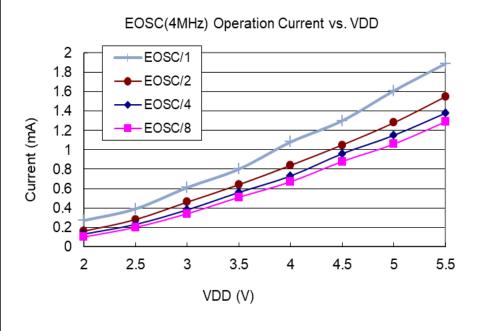
4.10. Typical operating current vs. VDD @ system clock = 4MHz EOSC / n

Conditions:

ON: EOSC, MISC.6 = 1;

OFF: Band-gap, LVR, IHRC, ILRC, T16 modules;

IO: PA0:0.5Hz output toggle and no loading, others: input and no floating





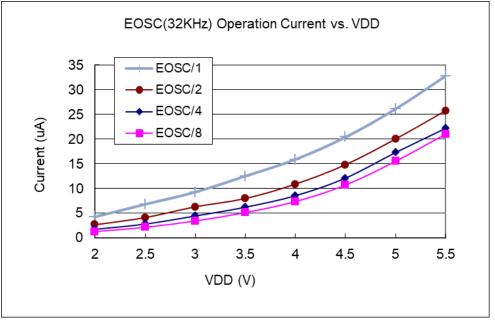
4.11. Typical operating current vs. VDD @ system clock = 32kHz EOSC / n

Conditions:

ON: EOSC;

OFF: Band-gap, LVR, IHRC, ILRC, T16 modules;

IO: PA0:0.5Hz output toggle and no loading, others: input and no floating



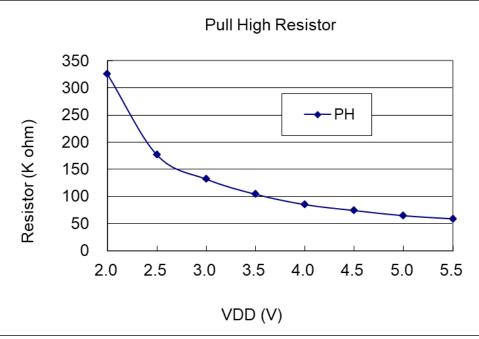
4.12. Typical IO pull high resistance

Conditions:

ON: EOSC, MISC.6 = 1;

OFF: Band-gap, LVR, IHRC, ILRC, T16 modules;

IO: PA0:0.5Hz output toggle and no loading, others: input and no floating





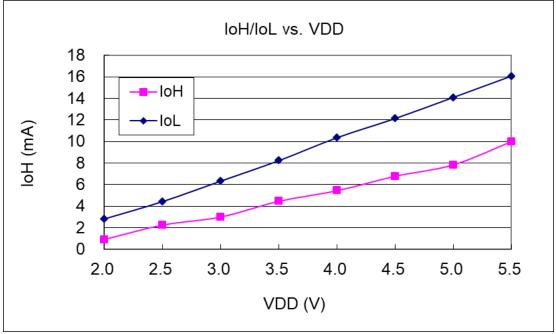
4.13. Typical IO driving current (I_{OH}) and sink current (I_{OL})

Conditions:

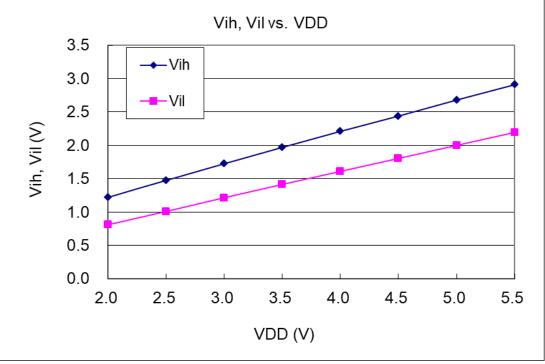
ON: EOSC, MISC.6 = 1;

OFF: Band-gap, LVR, IHRC, ILRC, T16 modules;

IO: PA0:0.5Hz output toggle and no loading, others: input and no floating

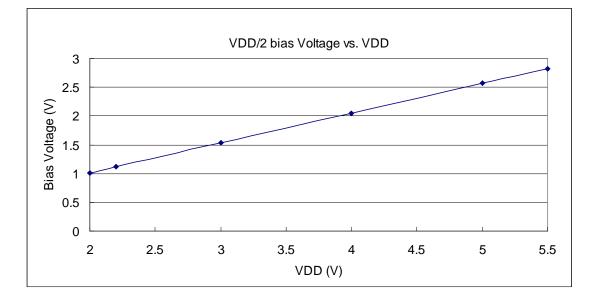


4.14. Typical IO input high / low threshold voltage (V_{IH}/V_{IL})



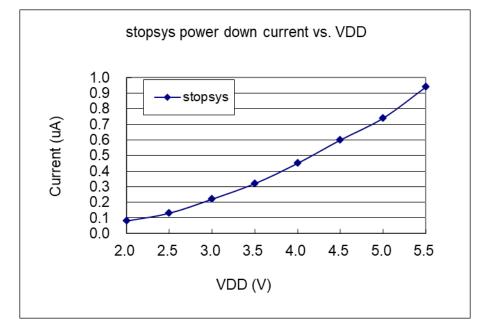


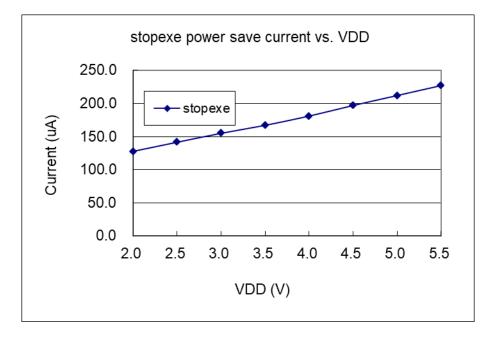
4.15. Typical VDD/2 Bias output voltage





4.16. Typical power down current (IPD) and power save current (IPS)







5. Functional Description

5.1. Program Memory – OTP

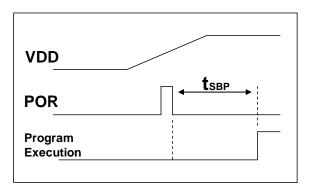
The OTP (One Time Programmable) program memory is used to store the program instructions to be executed. The OTP program memory may contains the data, tables and interrupt entry. After reset, the initial address for CPU is 0x000. The interrupt entry is 0x010 if used, the last eight addresses are reserved for system using, like checksum, serial number, etc. The OTP program memory for PMC156/PMS156 is a 1KW that is partitioned as Table 1. The OTP memory from address 0x3F8 to 0x3FF is for system using, address space from 0x001 to 0x00F and from 0x011 to 0x3F7 are user program spaces.

Address	Function	
0x000	Reset – goto instruction	
0x001	User program	
•	•	
•	•	
0x00F	User program	
0x010	Interrupt entry address	
0x011	User program	
• •		
0x3F7	User program	
0x3F8	System Using	
•	•	
0x3FF	System Using	

Table 1: Program Memory Organization of PMC156/PMS156

5.2. Boot Up

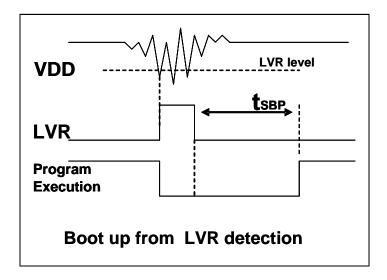
POR (Power-On-Reset) is used to reset PMC156/PMS156 when power up, however, the supply voltage may be not stable. To ensure the stability of supply voltage after power up, it will wait 1024 ILRC clock cycles before first instruction being executed, which is t_{SBP} and shown in the Fig. 1.

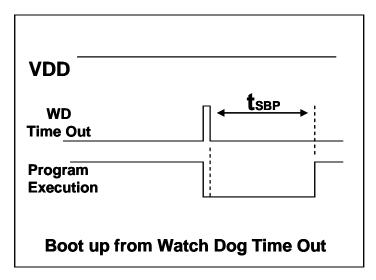


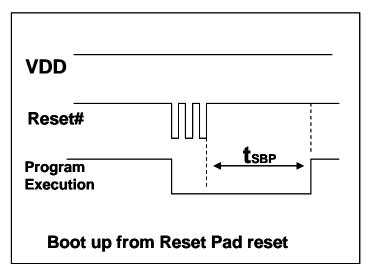
Boot up from Power-On Reset Fig. 1: Power Up Sequence



5.2.1 Timing charts for reset conditions









5.3. Data Memory – SRAM

The access of data memory can be byte or bit operation. Besides data storage, the SRAM data memory is also served as data pointer of indirect access method and the stack memory.

The stack memory is defined in the data memory. The stack pointer is defined in the stack pointer register; the depth of stack memory of each processing unit is defined by the user. The arrangement of stack memory fully flexible and can be dynamically adjusted by the user.

For indirect memory access mechanism, the data memory is used as the data pointer to address the data byte. All the data memory could be the data pointer; it's quite flexible and useful to do the indirect memory access. All the 64 bytes data memory of PMC156/PMS156 can be accessed by indirect access mechanism.

5.4. Oscillator and clock

There are three oscillator circuits provided by PMC156/PMS156: external crystal oscillator (EOSC), internal high RC oscillator (IHRC) and internal low RC oscillator (ILRC), and these three oscillators are enabled or disabled by registers eoscr.7, clkmd.4 and clkmd.2 independently. User can choose one of these three oscillators as system clock source and use *clkmd* register to target the desired frequency as system clock to meet different applications.

Oscillator Module	Enable/Disable
EOSC	eoscr.7
IHRC	clkmd.4
ILRC	clkmd.2

Table2: Three Oscillator Circuits provided by PMC156/PMS156

5.4.1. Internal High RC oscillator and Internal Low RC oscillator

After boot-up, the IHRC and ILRC oscillators are enabled. The frequency of IHRC can be calibrated to eliminate process variation by *ihrcr* register; normally it is calibrated to 16MHz. The frequency deviation can be within 2% normally after calibration and it still drifts slightly with supply voltage and operating temperature. Please refer to the measurement chart for IHRC frequency verse VDD and IHRC frequency verse temperature.

The frequency of ILRC will vary by process, supply voltage and temperature, please refer to DC specification and do not use for accurate timing application.

5.4.2. IHRC calibration

The IHRC frequency may be different chip by chip due to manufacturing variation, PMC156/PMS156 provide the IHRC frequency calibration to eliminate this variation, and this function can be selected when compiling user's program and the command will be inserted into user's program automatically. The calibration command is shown as below:

.ADJUST_IC SYSCLK=IHRC/(p1), IHRC=(p2)MHz, V_{DD} =(p3)V

Where,

p1=2, 4, 8, 16, 32; In order to provide different system clock.

p2=16 ~ 18; In order to calibrate the chip to different frequency, 16MHz is the usually one.

p3=2.2 ~ 5.5; In order to calibrate the chip under different supply voltage.



5.4.3. IHRC Frequency Calibration and System Clock

During compiling the user program, the options for IHRC calibration and system clock are shown as Table 3:

SYSCLK	CLKMD	IHRCR	Description
 Set IHRC / 2 	= 34h (IHRC / 2)	Calibrated	IHRC calibrated to 16MHz, CLK=8MHz (IHRC/2)
 Set IHRC / 4 	= 14h (IHRC / 4)	Calibrated	IHRC calibrated to 16MHz, CLK=4MHz (IHRC/4)
 Set IHRC / 8 	= 3Ch (IHRC / 8)	Calibrated	IHRC calibrated to 16MHz, CLK=2MHz (IHRC/8)
 Set IHRC / 16 	= 1Ch (IHRC / 16)	Calibrated	IHRC calibrated to 16MHz, CLK=1MHz (IHRC/16)
 Set IHRC / 32 	= 7Ch (IHRC / 32)	Calibrated	IHRC calibrated to 16MHz, CLK=0.5MHz (IHRC/32)
○ Set ILRC	= E4h (ILRC / 1)	Calibrated	IHRC calibrated to 16MHz, CLK=ILRC
 Disable 	No change	No Change	IHRC not calibrated, CLK not changed

Table 3: Options for IHRC Frequency Calibration

Usually, .ADJUST_IC will be the first command after boot up, in order to set the target operating frequency whenever stating the system. The program code for IHRC frequency calibration is executed only one time that occurs in writing the codes into OTP memory; after then, it will not be executed again. If the different option for IHRC calibration is chosen, the system status is also different after boot. The following shows the status of PMC156 for different option:

(1) .ADJUST_IC SYSCLK=IHRC/2, IHRC=16MHz, V_{DD}=5V

After boot up, CLKMD = 0x34:

- ♦ IHRC frequency is calibrated to 16MHz@V_{DD}=5V and IHRC module is enabled
- ◆ System CLK = IHRC/2 = 8MHz
- Watchdog timer is disabled, ILRC is enabled, PA5 is in input mode

(2) .ADJUST_IC SYSCLK=IHRC/4, IHRC=16MHz, V_{DD}=3.3V

After boot, CLKMD = 0x14:

- IHRC frequency is calibrated to 16MHz@V_{DD}=3.3V and IHRC module is enabled
- ◆ System CLK = IHRC/4 = 4MHz
- Watchdog timer is disabled, ILRC is enabled, PA5 is in input mode

(3) .ADJUST_IC SYSCLK=IHRC/8, IHRC=16MHz, V_{DD}=2.5V

After boot, CLKMD = 0x3C:

- IHRC frequency is calibrated to 16MHz@V_{DD}=2.5V and IHRC module is enabled
- System CLK = IHRC/8 = 2MHz
- Watchdog timer is disabled, ILRC is enabled, PA5 is in input mode

(4) .ADJUST_IC SYSCLK=IHRC/16, IHRC=16MHz, V_{DD}=2.2V

After boot, CLKMD = 0x1C:

- IHRC frequency is calibrated to 16MHz@V_{DD}=2.2V and IHRC module is enabled
- ♦ System CLK = IHRC/16 = 1MHz
- Watchdog timer is disabled, ILRC is enabled, PA5 is in input mode



(5) .ADJUST_IC SYSCLK=IHRC/32, IHRC=16MHz, V_{DD}=5V

After boot, CLKMD = 0x7C:

- ♦ IHRC frequency is calibrated to 16MHz@V_{DD}=5V and IHRC module is enabled
- System CLK = IHRC/32 = 500kHz
- Watchdog timer is disabled, ILRC is enabled, PA5 is in input mode

(6) .ADJUST_IC SYSCLK=ILRC, IHRC=16MHz, V_{DD}=5V

After boot, CLKMD = 0XE4:

- ◆ IHRC frequency is calibrated to 16MHz@V_{DD}=5V and IHRC module is disabled
- ♦ System CLK = ILRC
- Watchdog timer is enabled, ILRC is disabled, PA5 is input mode

(7) .ADJUST_IC DISABLE

After boot, CLKMD is not changed (Do nothing):

- IHRC is not calibrated and IHRC module is disabled. Band-gap is not calibrated.
- System CLK = ILRC
- Watchdog timer is enabled, ILRC is enabled, PA5 is in input mode

5.4.4. External Crystal Oscillator

If crystal oscillator is used, a crystal or resonator is required between X1 and X2. Fig. 2 shows the hardware connection under this application; <u>the range of operating frequency of crystal oscillator can be from 32 kHz to</u> <u>4MHz</u>, depending on the crystal placed on; higher frequency oscillator than 4MHz is NOT supported.

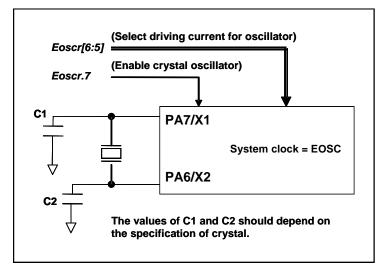


Fig. 2: Connection of crystal oscillator



Besides crystal, external capacitor and options of PMC156 should be fine tuned in *eoscr* (0x0a) register to have good sinusoidal waveform. The *eoscr*.7 is used to enable crystal oscillator module, *eoscr*.6 and *eoscr*.5 are used to set the different driving current to meet the requirement of different frequency of crystal oscillator:

- eoscr.[6:5]=01 : Low driving capability, for lower frequency, ex: 32kHz crystal oscillator
- eoscr.[6:5]=10 : Middle driving capability, for middle frequency, ex: 1MHz crystal oscillator
- eoscr.[6:5]=11 : High driving capability, for higher frequency, ex: 4MHz crystal oscillator

Table 4 shows the recommended values of C1 and C2 for different crystal oscillator; the measured start-up time under its corresponding conditions is also shown. Since the crystal or resonator had its own characteristic, the capacitors and start-up time may be slightly different for different type of crystal or resonator, please refer to its specification for proper values of C1 and C2.

Frequency	C1	C2	Measured Start-up time	Conditions
4MHz	4.7pF	4.7pF	6ms	(eoscr[6:5]=11, misc.6=0)
1MHz	10pF	10pF	11ms	(eoscr[6:5]=10, misc.6=0)
32kHz	22pF	22pF	450ms	(eoscr[6:5]=01, misc.6=0)

Table 4: Recommend values of C1 and C2 for crystal and resonator oscillators

When using the crystal oscillator, user must pay attention to the stable time of oscillator after enabling it, the stable time of oscillator will depend on frequency ` crystal type ` external capacitor and supply voltage. Before switching the system to the crystal oscillator, user must make sure the oscillator is stable; the reference program is shown as below:

```
void
        FPPA0 (void)
{
  . ADJUST IC SYSCLK=IHRC/16, IHRC=16MHz, VDD=5V
  $
       EOSCR
                Enable, 4Mhz;
                                   // EOSCR = 0b110 00000;
  $
       T16M
                 EOSC, /1, BIT13;
                                   // T16 receive 2^14=16384 clocks of crystal EOSC,
                                   // Intrg.T16 =>1, crystal EOSC is stable
  WORD
            count
                          0;
  stt16count;
  Intrq.T16 =
                0;
                                   // count from 0x0000 to 0x2000, then setINTRQ.T16
  wait1
            Intrg.T16;
  clkmd
                                   // switch system clock to EOSC;
            =
                0xB4;
  Clkmd.4 = 0;
                                   //disable IHRC
  ...
```

Please notice that the crystal oscillator should be fully turned off before entering the power-down mode, in order to avoid unexpected wakeup event. If the 32kHz crystal oscillator is used and extremely low operating current is required, *misc*.6 can be set to reduce current after crystal oscillator is running normally.



5.4.5. System Clock and LVR levels

The clock source of system clock comes from EOSC, IHRC and ILRC, the hardware diagram of system clock in the PMC156 is shown as Fig. 3.

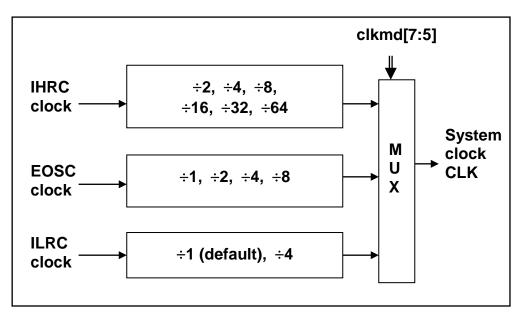


Fig. 3: Options of System Clock

User can choose different operating system clock depends on its requirement; the selected operating system clock should be combined with supply voltage and LVR level to make system stable. The LVR level will be selected during compilation and the lowest LVR levels can be chosen for different operating frequencies. Please refer to Section 4.1.



5.4.6. System Clock Switching

After IHRC calibration, user may want to switch system clock to a new frequency or may switch system clock at any time to optimize the system performance and power consumption. Basically, the system clock of PMC156 can be switched among IHRC, ILRC and EOSC by setting the *clkmd* register at any time; system clock will be the new one after writing to *clkmd* register immediately. Please notice that the original clock module can NOT be turned off at the same time as writing command to *clkmd* register. The examples are shown as below and more information about clock switching, please refer to the "Help -> Application Note -> "IC introduction" -> "Register introduction" -> "CLKMD".

Case 1: Switching system clock from ILRC to IHRC/2

			//	system clock is ILRC
CLKMD	=	0x34;	//	switch to IHRC/2 [,] ILRC <u>CAN NOT</u> be disabled here
CLKMD.2	=	0;	//	ILRC <u>CAN</u> be disabled at this time

Case 2: Switching system clock from ILRC to EOSC

			//	system clock is ILRC
CLKMD	=	0xA6;	//	switch to IHRC [,] ILRC <u>CAN NOT</u> be disabled here
CLKMD.2	=	0;	//	ILRC <u>CAN</u> be disabled at this time

Case 3: Switching system clock from IHRC/2 to ILRC

			//	system clock is IHRC/2
CLKMD	=	0xF4;	//	switch to ILRC [,] IHRC <u>CAN NOT</u> be disabled here
CLKMD.4	=	0;	//	IHRC <u>CAN</u> be disabled at this time

Case 4: Switching system clock from IHRC/2 to EOSC

			//	system clock is IHRC/2
CLKMD	=	0XB0;	//	switch to EOSC [,] IHRC <u>CAN NOT</u> be disabled here
CLKMD.4	=	0;	//	IHRC <u>CAN</u> be disabled at this time

Case 5: Switching system clock from IHRC/2 to IHRC/4

			//	system clock is IHRC/2, ILRC is enabled here
CLKMD	=	0X14;	//	switch to IHRC/4

Case 6: System may hang if it is to switch clock and turn off original oscillator at the same time

			//	system clock is ILRC
CLKMD	=	0x30;	//	CAN NOT switch clock from ILRC to IHRC/2 and
			//	turn off ILRC oscillator at the same time



5.5 16-bit Timer (Timer16)

A 16-bit hardware timer (Timer16) is implemented in the PMC156/PMS156, the clock sources of Timer16 may come from system clock (CLK), clock of external crystal oscillator (EOSC), internal high RC oscillator (IHRC), internal low RC oscillator (ILRC) and PA0, a multiplex is used to select clock output for the clock source. Before sending clock to the counter16, a pre-scaling logic with divided-by-1, 4, 16, and 64 is used for wide range counting. The 16-bit counter performs up-counting operation only, the counter initial values can be stored from memory by *stt16* instruction and the counting values can be loaded to memory by *ldt16* instruction. A selector is used to select the interrupt condition of Timer16, whenever overflow occurs, the Timer16 interrupt can be triggered. The hardware diagram of Timer16 is shown as Fig. 4. The interrupt source of Timer16 comes from one of bit 8 to 15 of 16-bit counter, and the interrupt type can be rising edge trigger or falling edge trigger which is specified in the bit 4 of *integs* register (IO address 0x0C).

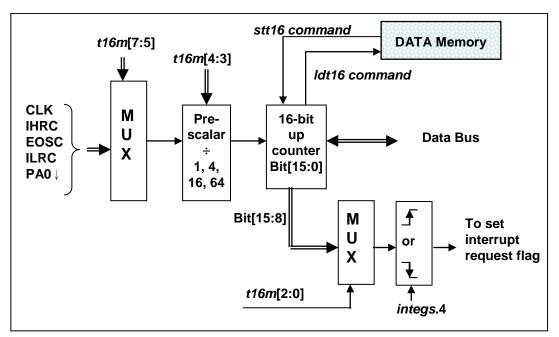


Fig. 4: Hardware diagram of Timer16

When using the Timer16, the syntax for Timer16 has been defined in the .INC file. There are three parameters to define the Timer16 using; 1st parameter is used to define the clock source of Timer16, 2nd parameter is used to define the pre-scalar and the 3rd one is to define the interrupt source.

T16M	IO_RW	0x06	
\$ 7~5:	STOP, SYSC	LK, X , PA4_F, IHRC, EOSC, ILRC, PA0_F	// 1 st par.
\$ 4~3:	/1, /4, /16, /64	1	// 2 nd par.
\$ 2~0:	BIT8, BIT9, E	8IT10, BIT11, BIT12, BIT13, BIT14, BIT15	// 3 rd par.



User can choose the proper parameters of T16M to meet system requirement, examples as below (For more examples, please refer to IDE software "Application Note \rightarrow Introduction of IC \rightarrow Introduction of Register \rightarrow T16M"):

\$ T16M SYSCLK, /64, BIT15;

// choose (SYSCLK/64) as clock source, every 2^16 clock to set INTRQ.2=1
// if using System Clock = IHRC / 2 = 8 MHz
// SYSCLK/64 = 8 MHz/64 = 125kHz, about every 512 mS to generate INTRQ.2=1

\$ T16M EOSC, /1, BIT13;

// choose (EOSC/1) as clock source, every 2^14 clocks to generate INTRQ.2=1
// if EOSC=32768 Hz, 32768 Hz/(2^14) = 2Hz, every 0.5S to generate INTRQ.2=1

\$ T16M PA0_F, /1, BIT8;

// choose PA0 as clock source, every 2^9 to generate INTRQ.2=1
// receiving every 512 times PA0 to generate INTRQ.2=1

\$ T16M STOP;

// stop Timer16 counting

If Timer16 is operated at free running, the frequency of interrupt can be described as below:

$F_{INTRQ_{T16M}} = F_{clock \ source} \div P \div 2^{n+1}$

Where,

F is the frequency of selected clock source to Timer16;

P is the selection of t16m [4:3]; (1, 4, 16, 64)

N is the nth bit selected to request interrupt service, for example: n=10 if bit 10 is selected.



5.6 Watchdog Timer

The watchdog timer (WDT) is a counter with clock coming from ILRC. There are three different timeout periods of watchdog timer can be chosen by setting the *misc* register, they are:

- 16384 ILRC clock period when misc[1:0]=10
- 4096 ILRC clock period when misc[1:0]=01
- 2048 ILRC clock period when misc[1:0]=00 (default)

The frequency of ILRC may drift a lot due to the variation of manufacture, supply voltage and temperature; user should reserve guard band for safe operation. WDT can be cleared by power-on-reset or by command *wdreset* at any time. When WDT is timeout, PMC156 will be reset to restart the program execution. The relative timing diagram of watchdog timer is shown as Fig. 5.

VDD	
	⊓ , t sbp
WD	←──→ ;
Time Out	
Program	
Execution	
Watch Dog Tin	ne Out Sequence

Fig. 5: Sequence of Watch Dog Time Out

5.7 Interrupt

There are three interrupt lines for PMC156:

- External interrupt PA0
- External interrupt PB0
- Timer16 interrupt

Every interrupt request line has its own corresponding interrupt control bit to enable or disable it; the hardware diagram of interrupt function is shown as Fig. 6. All the interrupt request flags are set by hardware and cleared by writing *intrq* register. When the request flags are set, it can be rising edge, falling edge or both, depending on the setting of register *integs*. All the interrupt request lines are also controlled by *engint* instruction (enable global interrupt) to enable interrupt operation and *disgint* instruction (disable global interrupt) to disable it. The stack memory for interrupt is shared with data memory and its address is specified by stack register *sp*. Since the program counter is 16 bits width, the bit 0 of stack register *sp* should be kept 0. Moreover, user can use *pushaf* / *popaf* instructions to store or restore the values of *ACC* and *flag* register *to* / *from* stack memory.



Since the stack memory is shared with data memory, the stack position and level are arranged by the compiler in Mini-C project. When defining the stack level in ASM project, users should arrange their locations carefully to prevent address conflicts.

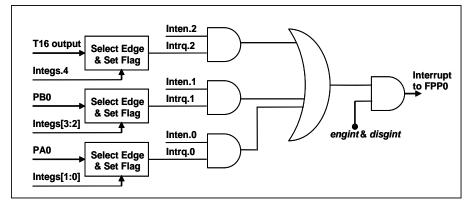


Fig. 6: Hardware diagram of Interrupt controller

Once the interrupt occurs, its operation will be:

- The program counter will be stored automatically to the stack memory specified by register sp.
- New *sp* will be updated to *sp+2*.
- Global interrupt will be disabled automatically.
- The next instruction will be fetched from address 0x010.

During the interrupt service routine, the interrupt source can be determined by reading the *intrq* register. Note: Even if INTEN=0, INTRQ will be still triggered by the interrupt source.

After finishing the interrupt service routine and issuing the *reti* instruction to return back, its operation will be:

- The program counter will be restored automatically from the stack memory specified by register sp.
- New sp will be updated to sp-2.
- Global interrupt will be enabled automatically.
- The next instruction will be the original one before interrupt.

User must reserve enough stack memory for interrupt, two bytes stack memory for one level interrupt and four bytes for two levels interrupt. For interrupt operation, the following sample program shows how to handle the interrupt, noticing that it needs four bytes stack memory to handle interrupt and *pushaf*.

```
void
              FPPA0
                       (void)
{
       $ INTEN PAO:
                                   INTEN =1; interrupt request when PA0 level changed
                               //
       INTRQ = 0;
                               //
                                    clear INTRQ
       ENGINT
                                    global interrupt enable
                               //
       ...
       DISGINT
                               //
                                    global interrupt disable
       ...
}
```



voi	d Interrupt	(void)	// interrupt service routine
{			
	PUSHAF		// store ALU and FLAG register
			opened and closed dynamically,
	// user ca	an judge whe	ther INTEN.PA0 =1 or not.
	// Examp	le: If (INTEN	N.PA0 && INTRQ.PA0) {}
		N.PA0 is alwa	
	// user ca	an omit the IN	ITEN.PA0 judgement to speed up interrupt service routine.
	lf (INTRG	D_PA()	
	{	(11710)	// Here for PA0 interrupt service routine
	-	RQ.PA0 = 0;	-
		NQ.FAU = 0,	
	}		
	7		
	 // <mark>X</mark> : INTF	RQ = 0;	// It is not recommended to use INTRQ = 0 to clear all at the end of
		·	// the interrupt service routine.
			// It may accidentally clear out the interrupts that have just occurred
			// and are not yet processed.
	POPAF		// restore ALU and FLAG register
1			" restore ALO and I LAO register
5			



5.8 Power-Save and Power-Down

There are three operational modes defined by hardware: ON mode, Power-Save mode and Power-Down modes. ON mode is the state of normal operation with all functions ON, Power-save mode ("*stopexe*") is the state to reduce operating current and CPU keeps ready to continue, Power-Down mode ("*stopsys*") is used to save power deeply. Therefore, Power-save mode is used in the system which needs low operating power with wake-up occasionally and Power-Down mode is used in the system which needs power down deeply with seldom wake-up. Fig. 7 shows the differences in oscillator modules between Power-Save mode ("*stopexe*") and Power-Down mode ("*stopsys*").

Differences in oscillator modules between STOPSYS and STOPEXE					
	IHRC	ILRC	EOSC		
STOPSYS	Stop	Stop	Stop		
STOPEXE	No Change	No Change	No Change		

Fig. 7: Differences in oscillator modules between STOPSYS and STOPEXE

5.8.1. Power-Save mode ("stopexe")

Using "*stopexe*" instruction to enter the Power-Save mode, only system clock is disabled, remaining all the oscillator modules active. For CPU, it stops executing; however, for Timer16, counter keep counting if its clock source is not the system clock. The wake-up sources for "*stopexe*" can be IO-toggle or Timer16 counts to the set values when clock sources of Timer16 come from IHRC, ILRC or EOSC modules. Wake-up from input pins can be considered as a continuation of normal execution, *nop* command is recommended to follow the *stopexe* command, the detail information for Power-Save mode shows below:

- IHRC and EOSC oscillator modules: No change, keep active if it was enabled
- ILRC oscillator modules: must remain enabled, need to start with ILRC when be wakening up.
- System clock: Disable, therefore, CPU stops execution
- OTP memory is turned off
- Timer16: Stop counting if system clock is selected or the corresponding oscillator module is disabled; otherwise, it keeps counting.
- Wake-up sources: IO toggle in digital mode (PxDIER bit is 1) or Timer16.

The watchdog timer must be disabled before issuing the "*stopexe*" command, the example is shown as below:

CLKMD.En_WatchDog	=	0;	// disable watchdog timer
stopexe;			
nop;			
			// power saving
Wdreset;			
CLKMD.En_WatchDog	=	1;	// enable watchdog timer



Another example shows how to use Timer16 to wake-up from "stopexe":

\$ T16M IHRC, /1, BIT8 // Timer16 setting WORD count = 0; STT16 count; stopexe; nop;

The initial counting value of Timer16 is zero and the system will be waken up after the Timer16 counts 256 IHRC clocks.

5.8.2. Power-Down mode ("stopsys")

Power-Down mode is the state of deeply power-saving with turning off all the oscillator modules. By using the "stopsys" instruction, this chip will be put on Power-Down mode directly. The internal low frequency RC oscillator must be enabled before entering the Power-Down mode, means that bit 2 of register *clkmd* (0x03) must be set to high before issuing "*stopsys*" command in order to resume the system when wakeup. The following shows the internal status of PMC156 in detail when "*stopsys*" command is issued:

- All the oscillator modules are turned off
- Enable internal low RC oscillator (set bit 2 of register *clkmd*)
- OTP memory is turned off
- The contents of SRAM and registers remain unchanged
- Wake-up sources: IO toggle in digital mode (PxDIER bit is 1)

Wake-up from input pins can be considered as a continuation of normal execution. To minimize power consumption, all the I/O pins should be carefully manipulated before entering power-down mode. The reference sample program for power down is shown as below:

CMKMD =	= 0xF4;	//	change clock from IHRC to ILRC, disable watchdog timer
CLKMD.4 =	= 0;	//	disable IHRC
while (1)			
{			
STOPSYS;		//	enter power-down
if (.) break;	//	if wakeup happen and check OK, then return to high speed,
		//	else stay in power-down mode again.
}			
CLKMD=	0x34;	//	change clock from ILRC to IHRC/2



5.8.3. Wake-up

After entering the Power-Down or Power-Save modes, the PMC156 can be resumed to normal operation by toggling IO pins, Timer16 interrupt is available for Power-Save mode ONLY. Fig. 8 shows the differences in wake-up sources between STOPSYS and STOPEXE.

Differences in wake-up sources between STOPSYS and STOPEXE				
	IO Toggle	T16 Interrupt		
STOPSYS	Yes	No		
STOPEXE	Yes	Yes		

Fig. 8: Differences in wake-up sources between Power-Save mode and Power-Down mode

When using the IO pins to wake-up the PMC156/PMS156, registers *padier* and *pbdier* should be properly set to enable the wake-up function for every corresponding pin. The wake-up time for normal wake-up is about 1024 ILRC clocks counting from wake-up event; fast wake-up can be selected to reduce the wake-up time by *misc* register. For fast wake-up mechanism, the wake-up time is 128 system clocks from IO toggling if STOPEXE was issued, and 128 system clocks plus oscillator (IHRC or ILRC) stable time from IO toggling if STOPSYS was issued. The oscillator stable time is the time for IHRC or ILRC oscillator from power-on, depending on which oscillator is used as system clock source. Please notice that there is no fast wake-up mode whenever EOSC is enabled.

Suspend mode	wake-up mode	system clock source	wake-up time (t _{wup}) from IO toggle
STOPEXE suspend	fast wake-up	IHRC or ILRC	128 * $T_{\text{SYS},}$ Where T_{SYS} is the time period of system clock
STOPSYS suspend	fast wake-up	IHRC	128 $T_{SYS +} T_{SIHRC}$; Where T_{SIHRC} is the stable time of IHRC from power-on.
STOPSYS suspend	fast wake-up	ILRC	128 $T_{SYS +} T_{SILRC}$; Where T_{SILRC} is the stable time of ILRC from power-on.
STOPSYS or STOPEXE suspend	fast wake-up	EOSC	1024 * T_{ILRC} , Where T_{ILRC} is the clock period of ILRC
STOPEXE suspend	normal wake-up	Any one	1024 * T_{ILRC} , Where T_{ILRC} is the clock period of ILRC
STOPSYS suspend	normal wake-up	Any one	1024 * T_{ILRC} , Where T_{ILRC} is the clock period of ILRC

Please notice that the clock source of watch-dog will be switched to system clock (for example: 4MHz) when fast wakeup is enabled. Therefore, for fast wake-up, recommending turning off the watchdog timer **when** enabling the fast wakeup. When wake-up, turning on the watchdog timer **after** disabling the fast wakeup.



To avoid unable wake-up problem happening from drifted process, please switch the system operating frequency to ILRC/1 before executing STOPSYS/STOPEXE instruction, and then switch to the original system operating frequency after waking-up, the example is shown as below:

\$ CLKMD	ILRC/1,En_IHRC,En_ILRC	//SYSCLK switch to ILRC
stopsys;		//Use stopsys or stopexe
\$ CLKMD	IHRC/n,En_IHRC,En_ILRC	//Switch to SYSCLK after waking-up



5.9 IO Pins

Other than PA5, all the pins can be independently set into two states output or input by configuring the data registers (*pa, pb*), control registers (*pac, pbc*) and pull-high registers (*paph, pbph*). All these pins have Schmitt-trigger input buffer and output driver with CMOS level. When it is set to output low, the pull-high resistor is turned off automatically. If user wants to read the pin state, please notice that it should be set to input mode before reading the data port; if user reads the data port when it is set to output mode, the reading data comes from data register, NOT from IO pad. As an example, Table 5 shows the configuration table of bit 0 of port A. The hardware diagram of IO buffer is also shown as Fig. 9.

pa.0	pac.0	paph.0	Description
Х	0	0	Input without pull-high resistor
Х	0	1	Input with pull-high resistor
0	1	Х	Output low without pull-high resistor
1	1	0	Output high without pull-high resistor
1	1	1	Output high with pull-high resistor

Table 5: PA0 Configuration Table

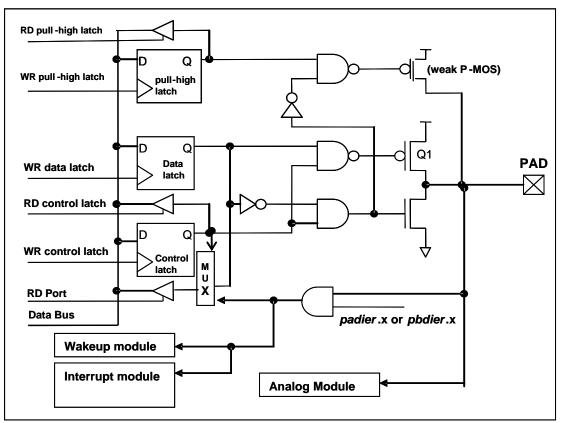


Fig. 9: Hardware diagram of IO buffer

Other than PA5, all the IO pins have the same structure; PA5 can be open-drain ONLY when setting to output mode (without Q1). When PMC156 is put in power-down or power-save mode, every pin can be used to wake-up system by toggling its state. Therefore, those pins needed to wake-up system must be set to input mode and set the corresponding bits of registers *padier* or *pbdier* to high. The same reason, *padier*.0 should be set high when PA0 is used as external interrupt pin and *pbdier*.0 for PB0.



5.10 Reset and LVR

5.10.1. Reset

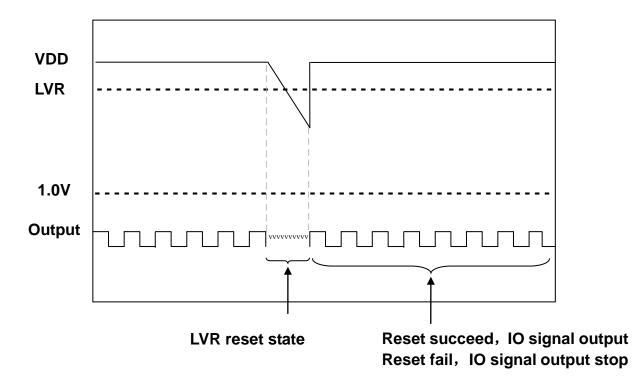
There are many causes to reset the PMC156/PMS156, once reset is asserted, all the registers in PMC156 will be set to default values, system should be restarted once abnormal cases happen, or by jumping program counter to address 'h0. The data memory is in uncertain state when reset comes from power-up and LVR; however, the content will be kept when reset comes from PRST# pin or WDT timeout.

5.10.2. LVR reset

By code option, there are many different levels of LVR for reset . Usually, user selects LVR reset level to be in conjunction with operating frequency and supply voltage.

5.10.3. Notice for LVR reset

In some applications, the power VDD may change rapidly because of quick switching the power source manually or strong power noise. In case, when the power VDD drops to the level that is lower than the LVR level but higher than 1.0V, if at this time the power VDD is pulled up again to be over LVR level (just see the diagram below), there may be some chances that cause the MCU malfunction or hanged.





To avoid the above problem, please follow the below steps in your program:

Step 1. Insert the below two instructions just after the .ADJUST_IC instruction

SET1 inten.7
Notice: IDE 0.57 or above version will insert this instruction automatically.
Intrq = 0;
Notice: IDE 0.59 or above version will insert this instruction automatically.

Step 2. Never clear the *inten.7* through out the whole program. Please pay special attention in accidental clear *inten.7* by writing operation to the whole *inten* register. Please consider using *set1/set0* instruction to change other interrupt enable flags.

Notice: IDE 0.57 or above version will block the reset operation of inten.7 automatically.

Step 3. When *wdreset* instruction is being used:

Please modify the *wdreset* instruction inside the main loop of the program:

C language:	If (inten.7==0) reset; else {wdreset;}		
Assembly language:	t1sn inten.7; reset wdreset		
or use as below :			
	.wdreset	(for IDE 0.57 or above version only)	

Step 4. When *clkmd* is being used:

When *clkmd* instruction is set inside the main loop of the program and *clkmd*.1 = 0, please insert below instructions afterward.

C language:	lf (inten.7==0) reset;		
Assembly language:	t1sn reset	inten.7;	
or use as below to set	clkmd:		
.clkma	/ = 0x hh	;	
(" la la " i a la assa al a airea al			

(" hh" is a hexadecimal value. For IDE 0.59 or above version only)



5.11 LCD Bias Voltage Generator

This function can be enabled by misc.4 and code option LCD2. There are two sets of pins can be selected as the LCD COM ports, four pins in each set. By selecting PA_1234 for LCD2, PA1, PA2, PA3 and PA4 are defined to output VDD/2 voltage during input mode, and be used as COM function for LCD applications. By selecting PB_1256 of LCD2, PB1, PB2, PB5 and PB6 are defined as COM ports.

If user wants to output VDD, VDD/2, GND three levels voltage, enabling VDD/2 bias voltage (by set misc.4=1), then set to output-high for VDD, with input mode for VDD/2, and output-low for GND correspondingly, Fig.10 shows how to use this function.

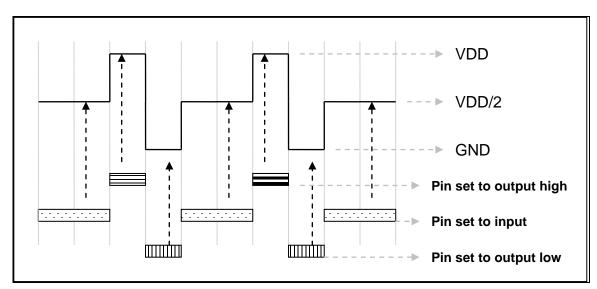


Fig. 10: Using VDD/2 bias voltage generator



6. IO Registers

6.1 ACC Status Flag Register (*flag*), IO address = 0x00

Bit	Reset	R/W	Description
7 – 4	-	-	Reserved. These four bits are "1" when read.
3	-	R/W	OV (Overflow). This bit is set whenever the sign operation is overflow.
2	-	R/W	AC (Auxiliary Carry). There are two conditions to set this bit, the first one is carry out of low nibble in addition operation, and the other one is borrow from the high nibble into low nibble in subtraction operation.
1	-	R/W	C (Carry). There are two conditions to set this bit, the first one is carry out in addition operation, and the other one is borrow in subtraction operation. Carry is also affected by shift with carry instruction.
0	-	R/W	Z (Zero). This bit will be set when the result of arithmetic or logic operation is zero; Otherwise, it is cleared.

6.2 Stack Pointer *Register* (*sp*), IO address = 0x02

Bit	Reset	R/W	Description
7 0	-	R/W	Stack Pointer Register. Read out the current stack pointer, or write to change the stack
7 – 0		Γ./ ٧ ٧	pointer. Please notice that bit 0 should be kept 0 due to program counter is 16 bits.

6.3 Clock Mode Register (*clkmd*), IO address = 0x03

Bit	Reset	R/W	Desci	ription
			System clock selection:	_
			Type 0, clkmd[3]=0	Type 1, clkmd[3]=1
			000: IHRC/4	000: IHRC/16
			001: IHRC/2	
		D 444	010: reserved	001: IHRC/8
7 – 5	111	R/W	011: EOSC/4	010: reserved
			100: EOSC/2	011: IHRC/32
			101: EOSC	100: IHRC/64
			110: ILRC/4	101: EOSC/8
			111: ILRC (default)	11X: reserved
4	1	R/W	IHRC oscillator Enable. 0 / 1: disable / enable)
3	0	D RW	Clock Type Select. This bit is used to select the	he clock type in bit [7:5].
3	0		0 / 1: Type 0 / Type 1	
2	1	R/W	ILRC Enable. 0 / 1: disable / enable	
			If ILRC is disabled, watchdog timer is also dis	sabled.
1	1	R/W	Watch Dog Enable. 0 / 1: disable / enable	
0	0	R/W	Pin PA5/PRST# function. 0 / 1: PA5 / PRST#	

6.4 Interrupt Enable Register (*inten*), IO address = 0x04

Bit	Reset	R/W	Description
7 – 3	-	R/W	Reserved.
2	-	R/W	Enable interrupt from Timer16 overflow. 0 / 1: disable / enable.
1	-	R/W	Enable interrupt from PB0. 0 / 1: disable / enable.
0	-	R/W	Enable interrupt from PA0. 0 / 1: disable / enable.

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6.5 Interrupt Request Register (*intrq*), IO address = 0x05

Bit	Reset	R/W	Description
7 – 3	-	R/W	Reserved.
2	-	R/W	Interrupt Request from Timer16, this bit is set by hardware and cleared by software. 0 / 1: No request / Request
1	-	R/W	Interrupt Request from pin PB0, this bit is set by hardware and cleared by software. 0 / 1: No request / Request
0	-	R/W	Interrupt Request from pin PA0, this bit is set by hardware and cleared by software. 0 / 1: No request / Request

6.6 Timer 16 mode Register (*t16m*), IO address = 0x06

Bit	Reset	R/W	Description
7 – 5	000	R/W	Timer Clock source selection 000: Timer 16 is disabled 001: CLK (system clock) 010: reserved 011: PA4 falling edge (from external pin) 100: IHRC 101: EOSC 110: ILRC 111: PA0 falling edge (from external pin)
4 – 3	00	R/W	Internal clock divider. 00: /1 01: /4 10: /16 11: /64
2-0	000	R/W	Interrupt source selection. Interrupt event happens when selected bit is changed. 0 : bit 8 of Timer16 1 : bit 9 of Timer16 2 : bit 10 of Timer16 3 : bit 11 of Timer16 4 : bit 12 of Timer16 5 : bit 13 of Timer16 6 : bit 14 of Timer16 7 : bit 15 of Timer16

6.7 External Oscillator setting Register (*eoscr, write only*), IO address = 0x0a

Bit	Reset	R/W	Description
7	0	WO	Enable external crystal oscillator. 0 / 1 : Disable / Enable
			External crystal oscillator selection.
			00 : reserved
6 – 5	00	WO	01 : Low driving capability, for lower frequency, ex: 32kHz crystal oscillator
			10 : Middle driving capability, for middle frequency, ex: 1MHz crystal oscillator
			11 : High driving capability, for higher frequency, ex: 4MHz crystal oscillator
4 – 1	-	-	Reserved. Please keep 0 for future compatibility.
0	0	WO	Power-down the Band-gap and LVR hardware modules. 0 / 1: normal / power-down.



6.8 IHRC oscillator control Register (*ihrcr, write only*), IO address = 0x0b

Bit	Reset	R/W	Description
7 0	-		Bit [7:0] of internal high RC oscillator for frequency calibration.
7 – 0		WO	For system using only, please user do NOT write this register.

6.9 Interrupt Edge Select Register (*integs*), IO address = 0x0c

Bit	Reset	R/W	Description
7 – 5	-	-	Reserved. Please keep 0.
			Timer16 edge selection.
4	0	WO	0 : rising edge to trigger interrupt
			1 : falling edge to trigger interrupt
			PB0 edge selection.
			00 : both rising edge and falling edge to trigger interrupt
3 – 2	00	WO	01 : rising edge to trigger interrupt
			10 : falling edge to trigger interrupt
			11 : reserved.
			PA0 edge selection.
			00 : both rising edge and falling edge to trigger interrupt
1 – 0	00	WO	01 : rising edge to trigger interrupt
			10 : falling edge to trigger interrupt
			11 : reserved.



6.10 Port A Digital Input Enable Register (*padier*), IO address = 0x0d

Bit	Reset	R/W	Description
			Enable PA7 digital input and wake-up event. 1 / 0 : enable / disable.
7	4	wo	This bit should be set to low to prevent leakage current when external crystal oscillator
7	1	VVO	is used. If this bit is set to low, PA7 can NOT be used to wake-up the system.
			Note: For ICE emulation, the function is disabled when this bit is "1" and "0" is enabled.
			Enable PA6 digital input and wake-up event. 1 / 0 : enable / disable.
6		wo	This bit should be set to low to prevent leakage current when external crystal oscillator
6	1	WO	is used. If this bit is set to low, PA6 can NOT be used to wake-up the system.
			Note: For ICE emulation, the function is disabled when this bit is "1" and "0" is enabled.
			Enable PA5 wake-up event. 1 / 0 : enable / disable.
5	1	WO	This bit can be set to low to disable wake-up from PA5 toggling.
			Note: For ICE emulation, wakeup is disabled when this bit is "1" and "0" is enabled.
	1		Enable PA4 digital input and wake-up event. 1 / 0 : enable / disable.
4		wo	If this bit is set to low, PA4 can NOT be used to wake-up the system.
			Note: For ICE emulation, the function is disabled when this bit is "1" and "0" is enabled.
			Enable PA3 digital input and wake-up event. 1 / 0 : enable / disable.
3	1	WO	If this bit is set to low, PA3 can NOT be used to wake-up the system.
			Note: For ICE emulation, the function is disabled when this bit is "1" and "0" is enabled.
			Enable PA2 wake-up event. 1 / 0 : enable / disable.
2	1	WO	This bit can be set to low to disable wake-up from PA2 toggling.
			Note: For ICE emulation, wakeup is disabled when this bit is "1" and "0" is enabled.
			Enable PA1 wake-up event. 1 / 0 : enable / disable.
1	1	WO	This bit can be set to low to disable wake-up from PA1 toggling.
			Note: For ICE emulation, wakeup is disabled when this bit is "1" and "0" is enabled.
			Enable PA0 wake-up event and interrupt request. 1 / 0 : enable / disable.
			This bit can be set to low to disable wake-up from PA0 toggling and interrupt request
0	1	WO	from this pin.
			Note : For ICE emulation, the function is disabled when this bit is "1" and "0" is enabled.



6.11 Port B Digital Input Enable Register (*pbdier*), IO address = 0x0e

Bit	Reset	R/W	Description
			Enable PB7 digital input and wake-up event. 1 / 0 : enable / disable.
7	1	WO	If this bit is set to low, PB7 can NOT be used to wake-up the system.
			Note: For ICE emulation, the function is disabled when this bit is "1" and "0" is enabled.
			Enable PB6 wake-up event. 1 / 0 : enable / disable.
6	1	WO	This bit can be set to low to disable wake-up from PB6 toggling.
			Note: For ICE emulation, wakeup is disabled when this bit is "1" and "0" is enabled.
			Enable PB5 wake-up event. 1 / 0 : enable / disable.
5	1	WO	This bit can be set to low to disable wake-up from PB5 toggling.
			Note: For ICE emulation, wakeup is disabled when this bit is "1" and "0" is enabled.
			Enable PB4 wake-up event. 1 / 0 : enable / disable.
4	1	WO	This bit can be set to low to disable wake-up from PB4 toggling.
			Note: For ICE emulation, wakeup is disabled when this bit is "1" and "0" is enabled.
			Enable PB3 digital input and wake-up event. 1 / 0 : enable / disable.
3	1	WO	If this bit is set to low, PB3 can NOT be used to wake-up the system.
			Note: For ICE emulation, the function is disabled when this bit is "1" and "0" is enabled.
			Enable PB2 digital input and wake-up event. 1 / 0 : enable / disable.
2	1	WO	If this bit is set to low, PB2 can NOT be used to wake-up the system.
			Note: For ICE emulation, the function is disabled when this bit is "1" and "0" is enabled.
			Enable PB1 digital input and wake-up event. 1 / 0 : enable / disable.
1	1	WO	If this bit is set to low, PB1 can NOT be used to wake-up the system.
			Note: For ICE emulation, the function is disabled when this bit is "1" and "0" is enabled.
			Enable PB0 digital input, wake-up event and interrupt request. 1 / 0 : enable / disable.
0	1	wo	If this bit is set to low, PB0 can NOT be used to wake-up the system and interrupt
			request from this pin.
			Note: For ICE emulation, the function is disabled when this bit is "1" and "0" is enabled.



6.12 Port A Data Registers (*pa*), IO address = 0x10

Bit	Reset	R/W	Description
7 – 0	0x00	R/W	Data registers for Port A.

6.13Port A Control Registers (*pac*), IO address = 0x11

	Bit	Reset	R/W	Description
7	7 – 0	0x00	R/W	Port A control registers. This register is used to define input mode or output mode for each corresponding pin of port A. 0 / 1: input / output.

6.14 Port A Pull-High Registers (*paph*), IO address = 0x12

Bit	Reset	R/W	Description
7 – 0	0x00	R/W	Port A pull-high registers. This register is used to enable the internal pull-high device on each corresponding pin of port A. 0 / 1 : disable / enable Please note that the PA5 does not have pull-high resistor.

6.15 Port B Data Registers (*pb*), IO address = 0x14

Bit	Reset	R/W	Description
7 – 0	0x00	R/W	Data registers for Port B.

6.16 Port B Control Registers (*pbc*), IO address = 0x15

Bit	Reset	R/W	Description
7 – 0	0x00	R/W	Port B control registers. This register is used to define input mode or output mode for each corresponding pin of port B. 0 / 1: input / output

6.17 Port B Pull-High Registers (*pbph*), IO address = 0x16

В	lit	Reset	R/W	Description
7 -	- 0	0x00	R/W	Port B pull-high registers. This register is used to enable the internal pull-high device on each corresponding pin of port B. 0 / 1 : disable / enable



6.18 MISC Register (*misc*), IO address = 0x3b

Bit	Reset	R/W	Description
7	-	-	Reserved
6	0	WO	Enable extremely low current for 32kHz crystal oscillator AFTER oscillation. 0: Normal. 1: Low driving current for 32kHz crystal oscillator.
5	0	WO	 Enable fast Wake-up. Fast wake-up is NOT supported when EOSC is enabled. 0: Normal wake-up. The wake-up time is 1024 ILRC clocks 1: Fast wake-up. The wake-up time is 128 CLKs (system clock) + oscillator stable time. If wake-up from STOPEXE suspend, there is no oscillator stable time; If wake-up from STOPSYS suspend, it will be IHRC or ILRC stable time from power-on. Please notice that the clock source will be switched to system clock (for example: 4MHz) when fast wakeup is enabled, therefore, it is recommended to turn off the watchdog timer before enabling the fast wakeup and turn on the watchdog timer after disabling the fast wakeup.
4	-	-	Enable VDD/2 LCD bias voltage generator. 0 / 1 : Disable / Enable (ICE cannot be dynamically switched) If Code Option selects LCD output, but MISC.4 does not set to 1, then the VDD/2 bias cannot be output on the IC. However, the emulator is always OK. Two above phenomena are different.
3	0	WO	Recover time from LVR reset. 0: Normal. The system will take about 1024 ILRC clocks to boot up from LVR reset. 1: Fast. The system will take about 64 ILRC clocks to boot up from LVR reset.
2	0	WO	Disable LVR function. 0 / 1 : Enable / Disable
1 – 0	00	WO	Watch dog time out period 00: 2048 ILRC clock period 01: 4096 ILRC clock period 10: 16384 ILRC clock period 11: Reserved



7. Instructions

Symbol	Description
ACC	Accumulator (Abbreviation of accumulator)
а	Accumulator (Symbol of accumulator in program)
sp	Stack pointer
flag	ACC status flag register
Ι	Immediate data
&	Logical AND
	Logical OR
\downarrow	Movement
٨	Exclusive logic OR
+	Add
_	Subtraction
~	NOT (logical complement, 1's complement)
F	NEG (2's complement)
OV	Overflow (The operational result is out of range in signed 2's complement number system)
Z	Zero (If the result of ALU operation is zero, this bit is set to 1)
С	Carry (The operational result is to have carry out for addition or to borrow carry for subtraction in unsigned number system)
AC	Auxiliary Carry (If there is a carry out from low nibble after the result of ALU operation, this bit is set to 1)
word	Only addressed in 0~0x1F (0~31) is allowed
M.n	Only addressed in 0~0xF (0~15) is allowed



7.1 Data Transfer Instructions

	a, I	Move immediate data into ACC.
		Example: <i>mov</i> a, 0x0f;
		Result: $a \leftarrow 0 \text{fh};$
		Affected flags: 『N』Z 『N』C 『N』AC 『N』OV
mov	M, a	Move data from ACC into memory
		Example: <i>mov</i> MEM, a;
		Result: MEM \leftarrow a
		Affected flags: 『N』Z 『N』C 『N』AC 『N』OV
mov a	a, M	Move data from memory into ACC
		Example: <i>mov</i> a, MEM ;
		Result: $a \leftarrow MEM$; Flag Z is set when MEM is zero.
		Affected flags: 『Y』Z 『N』C 『N』AC 『N』OV
mov	a, IO	Move data from IO into ACC
		Example: <i>mov</i> a, pa ;
		Result: $a \leftarrow pa$; Flag Z is set when pa is zero.
		Affected flags: 『Y』Z 『N』C 『N』AC 『N』OV
mov	IO, a	Move data from ACC into IO
		Example: <i>mov</i> pb, a;
		Result: $pb \leftarrow a$
		Affected flags: "N_Z "N_C "N_AC "N_OV
ldt16 v	vora	Move 16-bit counting values in Timer16 to memory in word.
		Example: <i>Idt16</i> word; Result: word ← 16-bit timer
		Affected flags: $[N_J Z = [N_J C = [N_J A C = [N_J O V]]$
		Application Example:
		word T16val ; // declare a RAM word
		 <i>clear</i> lb@ T16val ; // clear T16val (LSB)
		clear hb@ T16val ; // clear T16val (MSB)
		stt16 T16val ; // initial T16 with 0
		set1 t16m.5; // enable Timer16
		set0 t16m.5; // disable Timer 16
		Idt16 T16val ; // save the T16 counting value to T16val



stt16	word	Store 16-bit data from memory in word to Timer16.
		Example: stt16 word;
		Result: 16-bit timer ←word
		Affected flags: 『N』Z 『N』C 『N』AC 『N』OV
		Application Example:
		word T16val ; // declare a RAM word
		<i>mov</i> a, 0x34 ;
		mov lb@ T16val , a ; // move 0x34 to T16val (LSB)
		<i>mov</i> a, 0x12 ;
		<i>mov</i> hb@ T16val , a ; // move 0x12 to T16val (MSB)
		stt16 T16val ; // initial T16 with 0x1234
idxm	a, index	Move data from specified memory to ACC by indirect method. It needs 2T to execute this
		instruction.
		Example: <i>idxm</i> a, index;
		Result: $a \leftarrow [index]$, where index is declared by word.
		Affected flags: N ₂ Z N ₂ C N ₂ AC N ₂ OV
		Application Example:
		word RAMIndex ; // declare a RAM pointer
		mov a, 0x5B; // assign pointer to an address (LSB)
		mov Ib@RAMIndex, a; // save pointer to RAM (LSB)
		mov a, 0x00 ; // assign 0x00 to an address (MSB), should be 0
		mov hb@RAMIndex, a; // save pointer to RAM (MSB)
		<i>idxm</i> a, RAMIndex ; // mov memory data in address 0x5B to ACC
ldxm	index, a	Move data from ACC to specified memory by indirect method. It needs 2T to execute this
		instruction.
		Example: <i>idxm</i> index, a;
		Result: [index] \leftarrow a; where index is declared by word.
		Affected flags: 『N』Z 『N』C 『N』AC 『N』OV



	Application Example:
	word RAMIndex ; // declare a RAM pointer
	 mov a, 0x5B ; // assign pointer to an address (LSB)
	mov Ib@RAMIndex, a ; // save pointer to RAM (LSB)
	<i>mov</i> a, 0x00 ; // assign 0x00 to an address (MSB), should be 0
	mov hb@RAMIndex, a; // save pointer to RAM (MSB)
	<i>mov</i> a, 0xA5 ;
	<i>idxm</i> RAMIndex, a ; // mov 0xA5 to memory in address 0x5B
xch M	Exchange data between ACC and memory
	Example: <i>xch</i> MEM ;
	Result: MEM \leftarrow a , a \leftarrow MEM
	Affected flags: 『N』Z 『N』C 『N』AC 『N』OV
pushaf	Move the ACC and flag register to memory that address specified in the stack pointer.
	Example: <i>pushaf</i> ,
	Result: $[sp] \leftarrow \{flag, ACC\};$
	sp ← sp + 2 ; Affected flags: 『N』Z 『N』C 『N』AC 『N』OV
	Application Example:
	.romadr 0x10 ; // ISR entry address
	pushaf; // put ACC and flag into stack memory
	// ISR program
	… // ISR program
	popaf; // restore ACC and flag from stack memory
	reti;
popaf	Restore <i>ACC</i> and <i>flag</i> from the memory which address is specified in the stack pointer.
-	Example: popaf,
	Result: $sp \leftarrow sp - 2$;
	$\{Flag, ACC\} \leftarrow [sp];$
	Affected flags: 『Y』Z 『Y』C 『Y』AC 『Y』OV

7.2 Arithmetic Operation Instructions

add	a, I	Add immediate data with ACC, then put result into ACC
		Example: add a, 0x0f;
		Result: a ← a + 0fh
		Affected flags: 『Y』Z 『Y』C 『Y』AC 『Y』OV
add	a, M	Add data in memory with ACC, then put result into ACC
		Example: add a, MEM ;
		Result: a ← a + MEM
		Affected flags: 『Y』Z 『Y』C 『Y』AC 『Y』OV



<i>add</i> M, a	Add data in memory with ACC, then put result into memory
	Example: add MEM, a;
	Result: MEM \leftarrow a + MEM
	Affected flags: 『Y』Z 『Y』C 『Y』AC 『Y』OV
<i>addc</i> a, M	Add data in memory with ACC and carry bit, then put result into ACC
	Example: <i>addc</i> a, MEM ;
	Result: $a \leftarrow a + MEM + C$
	Affected flags: 『Y』Z 『Y』C 『Y』AC 『Y』OV
<i>addc</i> M, a	Add data in memory with ACC and carry bit, then put result into memory
	Example: <i>addc</i> MEM, a ;
	Result: MEM \leftarrow a + MEM + C
	Affected flags: 『Y』Z 『Y』C 『Y』AC 『Y』OV
<i>addc</i> a	Add carry with ACC, then put result into ACC
	Example: <i>addc</i> a ;
	Result: $a \leftarrow a + C$
	Affected flags: 『Y』Z 『Y』C 『Y』AC 『Y』OV
addc M	Add carry with memory, then put result into memory
	Example: <i>addc</i> MEM ;
	Result: MEM \leftarrow MEM + C
	Affected flags: 『Y』Z 『Y』C 『Y』AC 『Y』OV
sub a, l	Subtraction immediate data from ACC, then put result into ACC.
	Example: <i>sub</i> a, 0x0f;
	Result: $a \leftarrow a$ - 0fh ($a + [2's complement of 0fh]$)
	Affected flags: 『Y』Z 『Y』C 『Y』AC 『Y』OV
sub a, M	Subtraction data in memory from ACC, then put result into ACC
	Example: <i>sub</i> a, MEM ;
	Result: $a \leftarrow a - MEM (a + [2's complement of M])$
	Affected flags: 『Y』Z 『Y』C 『Y』AC 『Y』OV
sub M, a	Subtraction data in ACC from memory, then put result into memory
	Example: sub MEM, a;
	Result: MEM \leftarrow MEM - a (MEM + [2's complement of a])
	Affected flags: 『Y』Z 『Y』C 『Y』AC 『Y』OV
subc a, M	Subtraction data in memory and carry from ACC, then put result into ACC
	Example: subc a, MEM;
	Result: a ← a − MEM - C
	Affected flags: 『Y』Z 『Y』C 『Y』AC 『Y』OV
subc M, a	Subtraction ACC and carry bit from memory, then put result into memory
,	Example: subc MEM, a ;
	Result: MEM ← MEM − a - C
	Affected flags: 『Y』Z 『Y』C 『Y』AC 『Y』OV
subc a	Subtraction carry from ACC, then put result into ACC
	Example: subc a;
	Result: $a \leftarrow a - C$
	Affected flags: 『Y』Z 『Y』C 『Y』AC 『Y』OV
subc M	Subtraction carry from the content of memory, then put result into memory
	Example: subc MEM;
	Result: MEM \leftarrow MEM - C
	Affected flags: $[Y_] Z [Y_] C [Y_] AC [Y_] OV$

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inc M	Increment the content of memory
	Example: <i>inc</i> MEM ;
	Result: MEM \leftarrow MEM + 1
	Affected flags: 『Y』Z 『Y』C 『Y』AC 『Y』OV
dec M	Decrement the content of memory
	Example: <i>dec</i> MEM;
	Result: MEM \leftarrow MEM - 1
	Affected flags: 『Y』Z 『Y』C 『Y』AC 『Y』OV
clear M	Clear the content of memory
	Example: <i>clear</i> MEM ;
	Result: MEM $\leftarrow 0$
	Affected flags: 『N』Z 『N』C 『N』AC 『N』OV

7.3 Shift Operation Instructions

sr a	Shift right of ACC, shift 0 to bit 7
	Example: <i>sr</i> a;
	Result: a (0,b7,b6,b5,b4,b3,b2,b1) ← a (b7,b6,b5,b4,b3,b2,b1,b0), C ← a(b0)
	Affected flags: 『N』Z 『Y』C 『N』AC 『N』OV
src a	Shift right of ACC with carry bit 7 to flag
	Example: <i>src</i> a;
	Result: a (c,b7,b6,b5,b4,b3,b2,b1) ← a (b7,b6,b5,b4,b3,b2,b1,b0), C ← a(b0)
	Affected flags: 『N』Z 『Y』C 『N』AC 『N』OV
sr M	Shift right the content of memory, shift 0 to bit 7
	Example: <i>sr</i> MEM ;
	Result: MEM(0,b7,b6,b5,b4,b3,b2,b1) ← MEM(b7,b6,b5,b4,b3,b2,b1,b0), C ← MEM(b0)
	Affected flags: 『N』Z 『Y』C 『N』AC 『N』OV
src M	Shift right of memory with carry bit 7 to flag
	Example: src MEM;
	Result: MEM(c,b7,b6,b5,b4,b3,b2,b1) ← MEM (b7,b6,b5,b4,b3,b2,b1,b0), C ← MEM(b0)
	Affected flags: 『N』Z 『Y』C 『N』AC 『N』OV
sl a	Shift left of ACC shift 0 to bit 0
	Example: s/ a;
	Result: a (b6,b5,b4,b3,b2,b1,b0,0) ← a (b7,b6,b5,b4,b3,b2,b1,b0), C ← a (b7)
	Affected flags: 『N』Z 『Y』C 『N』AC 『N』OV
s <i>lc</i> a	Shift left of ACC with carry bit 0 to flag
	Example: <i>slc</i> a ;
	Result: a (b6,b5,b4,b3,b2,b1,b0,c) ← a (b7,b6,b5,b4,b3,b2,b1,b0), C ← a(b7)
	Affected flags: 『N』Z 『Y』C 『N』AC 『N』OV
s/ M	Shift left of memory, shift 0 to bit 0
	Example: s/ MEM;
	Result: MEM (b6,b5,b4,b3,b2,b1,b0,0) ← MEM (b7,b6,b5,b4,b3,b2,b1,b0), C ← MEM(b7)
	Affected flags: 『N』Z 『Y』C 『N』AC 『N』OV
s <i>l</i> c M	Shift left of memory with carry bit 0 to flag
	Example: <i>slc</i> MEM ;
	Result: MEM (b6,b5,b4,b3,b2,b1,b0,C) ← MEM (b7,b6,b5,b4,b3,b2,b1,b0), C ← MEM (b7)
	Affected flags: 『N』Z 『Y』C 『N』AC 『N』OV



M, a

Example:

Result:

xor

PMC156/PMS156 Series 8bit OTP Type IO Controller

014/01 0	Swon the high nibble and low nibble of ACC
<i>swap</i> a	Swap the high nibble and low nibble of ACC
	Example: swap a;
	Result: a $(b3,b2,b1,b0,b7,b6,b5,b4) \leftarrow a (b7,b6,b5,b4,b3,b2,b1,b0)$
	Affected flags: 『N』Z 『N』C 『N』AC 『N』OV
<u> </u>	peration Instructions
and a, I	Perform logic AND on ACC and immediate data, then put result into ACC
	Example: and a, 0x0f;
	Result: a ← a & 0fh
	Affected flags: 『Y』Z 『N』C 『N』AC 『N』OV
<i>and</i> a, M	Perform logic AND on ACC and memory, then put result into ACC
	Example: and a, RAM10 ;
	Result: a ← a & RAM10
	Affected flags: 『Y』Z 『N』C 『N』AC 『N』OV
and M, a	Perform logic AND on ACC and memory, then put result into memory
	Example: and MEM, a ;
	Result: MEM \leftarrow a & MEM
	Affected flags: 『Y』Z 『N』C 『N』AC 『N』OV
or a, l	Perform logic OR on ACC and immediate data, then put result into ACC
	Example: or a, 0x0f;
	Result: $a \leftarrow a \mid 0$ fh
	Affected flags: 『Y』Z 『N』C 『N』AC 『N』OV
or a, M	Perform logic OR on ACC and memory, then put result into ACC
	Example: or a, MEM;
	Result: $a \leftarrow a \mid MEM$
	Affected flags: 『Y』Z 『N』C 『N』AC 『N』OV
or M, a	Perform logic OR on ACC and memory, then put result into memory
	Example: or MEM, a ;
	Result: MEM \leftarrow a MEM
	Affected flags: 『Y』Z 『N』C 『N』AC 『N』OV
<i>xor</i> a, l	Perform logic XOR on ACC and immediate data, then put result into ACC
	Example: xor a, 0x0f;
	Result: $a \leftarrow a^{0}$ Ofh
	Affected flags: 『Y』Z 『N』C 『N』AC 『N』OV
<i>xor</i> IO, a	Perform logic XOR on ACC and IO register, then put result into IO register
	Example: xor pa, a;
	Result: $pa \leftarrow a^pa$; // pa is the data register of port A
	Affected flags: 『N』Z 『N』C 『N』AC 『N』OV
<i>xor</i> a, M	Perform logic XOR on ACC and memory, then put result into ACC
	Example: <i>xor</i> a, MEM ;
	Result: $a \leftarrow a^{A}RAM10$
	Affected flags: 『Y』Z 『N』C 『N』AC 『N』OV
	Destance leave VOD as ACC and searching them such as within the second second

xor MEM, a ; MEM ← a ^ MEM

Affected flags: "Y Z N C N AC

Perform logic XOR on ACC and memory, then put result into memory

 ${{}^{\mathbb{\Gamma}}{\mathsf{N}}}\,{}_{\mathbb{J}}\,\,{\mathsf{OV}}$



	1
<i>not</i> a	Perform 1's complement (logical complement) of ACC Example: not a ; Result: $a \leftarrow \sim a$ Affected flags: $\[Y \] Z \[N \] C \[N \] AC \[N \] OV$ Application Example:
	mov a, 0x38; // ACC=0X38 not a; // ACC=0XC7
not M	Perform 1's complement (logical complement) of memory Example: not MEM ; Result: MEM ← ~MEM Affected flags: 『Y』Z 『N』C 『N』OV
	Application Example:
	mov a, 0x38 ; mov mem, a ; // mem = 0x38 not mem ; // mem = 0xC7
neg a	Perform 2's complement of ACC Example: neg a; Result: a ← 〒a Affected flags: 『Y』Z 『N』C 『N』AC 『N』OV
	Application Example:
	<i>mov</i> a, 0x38 ; // ACC=0X38 <i>neg</i> a ; // ACC=0XC8
neg M	Perform 2's complement of memory Example: neg MEM; Result: MEM ← 〒MEM Affected flags: 『Y』Z 『N』C 『N』OV
	Application Example:
	mov a, 0x38 ; mov mem, a ; // mem = 0x38 not mem ; // mem = 0xC8



7.5 Bit Operation Instructions

Set bit n of IO port to low
Example: <i>set0</i> pa.5;
Result: set bit 5 of port A to low
Affected flags: 『N』Z 『N』C 『N』AC 『N』OV
Set bit n of IO port to high
Example: <i>set1</i> pb.5 ;
Result: set bit 5 of port B to high
Affected flags: 『N』Z 『N』C 『N』AC 『N』OV
Set bit n of memory to low
Example: <i>set0</i> MEM.5 ;
Result: set bit 5 of MEM to low
Affected flags: 『N』Z 『N』C 『N』AC 『N』OV
Set bit n of memory to high
Example: <i>set1</i> MEM.5 ;
Result: set bit 5 of MEM to high
Affected flags: 『N』Z 『N』C 『N』AC 『N』OV

7.6 Conditional Operation Instructions

<i>ceqsn</i> a, l	Compare ACC with immediate data and skip next instruction if both are equal.
	Flag will be changed like as (a \leftarrow a - I)
	Example: <i>ceqsn</i> a, 0x55 ;
	inc MEM;
	goto error;
	Result: If a=0x55, then "goto error"; otherwise, "inc MEM".
	Affected flags: 『Y』Z 『Y』C 『Y』AC 『Y』OV
<i>ceqsn</i> a, M	Compare ACC with memory and skip next instruction if both are equal.
	Flag will be changed like as (a \leftarrow a - M)
	Example: <i>ceqsn</i> a, MEM;
	Result: If a=MEM, skip next instruction
	Affected flags: 『Y』Z 『Y』C 『Y』AC 『Y』OV
<i>t0sn</i> IO.n	Check IO bit and skip next instruction if it's low
	Example: <i>t0sn</i> pa.5;
	Result: If bit 5 of port A is low, skip next instruction
	Affected flags: 『N』Z 『N』C 『N』AC 『N』OV
<i>t1sn</i> IO.n	Check IO bit and skip next instruction if it's high
	Example: <i>t1sn</i> pa.5 ;
	Result: If bit 5 of port A is high, skip next instruction
	Affected flags: 『N』Z 『N』C 『N』AC 『N』OV



<i>t0sn</i> M.n	Check memory bit and skip next instruction if it's low						
	Example: t0sn MEM.5;						
	Result: If bit 5 of MEM is low, then skip next instruction						
	Affected flags: 『N』Z 『N』C 『N』AC 『N』OV						
<i>t1sn</i> M.n	Check memory bit and skip next instruction if it's high						
	EX: t1sn MEM.5;						
	Result: If bit 5 of MEM is high, then skip next instruction						
	Affected flags: 『N』Z 『N』C 『N』AC 『N』OV						
izsn a	Increment ACC and skip next instruction if ACC is zero						
	Example: <i>izsn</i> a;						
	Result: $a \leftarrow a + 1$, skip next instruction if $a = 0$						
	Affected flags: 『Y』Z 『Y』C 『Y』AC 『Y』OV						
dzsn a	Decrement ACC and skip next instruction if ACC is zero						
	Example: <i>dzsn</i> a;						
	Result: A \leftarrow A - 1,skip next instruction if a = 0						
	Affected flags: 『Y』Z 『Y』C 『Y』AC 『Y』OV						
izsn M	Increment memory and skip next instruction if memory is zero						
	Example: <i>izsn</i> MEM;						
	Result: MEM ← MEM + 1, skip next instruction if MEM= 0						
	Affected flags: 『Y』Z 『Y』C 『Y』AC 『Y』OV						
dzsn M	Decrement memory and skip next instruction if memory is zero						
	Example: <i>dzsn</i> MEM;						
	Result: MEM ← MEM - 1, skip next instruction if MEM = 0						
	Affected flags: 『Y』Z 『Y』C 『Y』AC 『Y』OV						

7.7 System control Instructions

call label	Function call, address can be full range address space						
	Example: <i>call</i> function1;						
	Result: [sp] ← pc + 1						
	pc ← function1						
	$sp \leftarrow sp + 2$						
	Affected flags: 『N』Z 『N』C 『N』AC 『N』OV						
goto label	Go to specific address which can be full range address space						
	Example: goto error;						
	Result: Go to error and execute program.						
	Affected flags: 『N』Z 『N』C 『N』AC 『N』OV						
ret I	Place immediate data to ACC, then return						
	Example: <i>ret</i> 0x55;						
	Result: $A \leftarrow 55h$						
	ret ;						
	Affected flags: 『N』Z 『N』C 『N』AC 『N』OV						
ret	Return to program which had function call						
	Example: ret;						
	Result: sp \leftarrow sp - 2						
	$pc \leftarrow [sp]$						
	Affected flags: 『N』Z 『N』C 『N』AC 『N』OV						

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reti	Return to program that is interrupt service routine. After this command is executed, global							
	interrupt is enabled automatically.							
	Example: <i>reti</i> ;							
	Affected flags: 『N』Z 『N』C 『N』AC 『N』OV							
nop	No operation							
	Example: nop;							
	Result: nothing changed							
noodd o	Affected flags: 『N』Z 『N』C 『N』AC 『N』OV							
pcadd a	Next program counter is current program counter plus ACC. Example: <i>pcadd a</i> ;							
	Result: $pc \leftarrow pc + a$							
	Affected flags: $[N_{J}Z = [N_{J}C = [N_{J}AC = [N_{J}OV]]$							
	Application Example:							
	mov a, 0x02 ;							
	pcadd a; // PC <- PC+2							
	goto err1;							
	goto correct ; // jump here							
	goto err2 ;							
	goto err3 ;							
	correct: // jump here							
engint	Enable global interrupt enable							
	Example: <i>engint</i> ,							
	Result: Interrupt request can be sent to CPU							
	Affected flags: 『N』Z 『N』C 『N』AC 『N』OV							
disgint	Disable global interrupt enable							
	Example: disgint ;							
	Result: Interrupt request is blocked from CPU							
atopolyo	Affected flags: $\mathbb{N}_{\mathbb{Z}} \mathbb{Z}$ $\mathbb{N}_{\mathbb{Z}} \mathbb{C}$ $\mathbb{N}_{\mathbb{Z}} \mathbb{A} \mathbb{C}$ $\mathbb{N}_{\mathbb{Z}} \mathbb{O} \mathbb{V}$ System halt.							
stopsys	Example: stopsys;							
	Result: Stop the system clocks and halt the system							
	Affected flags: "N _J Z "N _J C "N _J AC "N _J OV							
stopexe	CPU halt. The oscillator module is still active to output clock, however, system clock is disabled							
	to save power.							
	Example: stopexe;							
	Result: Stop the system clocks and keep oscillator modules active. Affected flags: 『N』Z 『N』C 『N』AC 『N』OV							
reset	Reset the whole chip, its operation will be same as hardware reset.							
10001	Example: reset,							
	Result: Reset the whole chip.							
	Affected flags: 『N』Z 『N』C 『N』AC 『N』OV							



wdreset	Reset Watchdog timer.						
	Example: wdreset;						
	Result: Reset Watchdog timer.						
	Affected flags: 『N』Z 『N』C 『N』AC 『N』OV						

7.8 Summary of Instructions Execution Cycle

2T		goto, call, idxm, pcadd, ret, reti				
2T	Condition is fulfilled	and an energy than then then inch				
1T	Condition is not fulfilled	ceqsn, cneqsn,t0sn, t1sn, dzsn, izsn				
1T		Others				



Instruction	Z	С	AC	ov	Instruction	Ζ	С	AC	ov	Instruction	Z	С	AC	ov
mov a, l	-	-	-	-	<i>mov</i> M, a	-	-	-	-	<i>mov</i> a, M	Υ	-	-	-
<i>mov</i> a, IO	Υ	-	-	-	<i>mov</i> IO, a	I	-	-	-	<i>ldt16</i> word	-	-	-	-
stt16 word	-	1	-	-	<i>idxm</i> a, index	I	1	-	-	<i>idxm</i> index, a	-	I	-	I
xch M	-	1	-	-	pushaf	I	I	-	-	popaf	Υ	Y	Υ	Y
add a, I	Υ	Y	Y	Y	add a, M	Y	Y	Y	Y	add M, a	Y	Y	Y	Y
<i>addc</i> a, M	Υ	Υ	Υ	Υ	addc M, a	Y	Υ	Υ	Υ	addc a	Υ	Υ	Υ	Υ
addc M	Υ	Y	Y	Y	sub a, l	Y	Y	Y	Y	<i>sub</i> a, M	Y	Y	Y	Y
<i>sub</i> M, a	Υ	Υ	Y	Υ	<i>subc</i> a, M	Υ	Y	Υ	Y	<i>subc</i> M, a	Y	Y	Y	Y
<i>subc</i> a	Υ	Y	Y	Y	subc M	Y	Y	Y	Y	inc M	Y	Y	Y	Y
dec M	Υ	Y	Υ	Υ	clear M	I	1	-	-	sr a	-	Y	-	I
src a	-	Y	-	-	sr M	I	Y	-	-	src M	-	Y	-	I
sl a	-	Y	-	-	slc a	I	Y	-	-	s/ M	-	Y	-	I
slc M	-	Υ	-	-	swap a	-	-	-	-	and a, l	Υ	-	-	-
and a, M	Υ	1	-	-	and M, a	Υ	1	-	-	or a, l	Υ	I	-	I
or a, M	Υ	1	-	-	or M, a	Υ	1	-	-	<i>xor</i> a, l	Υ	I	-	1
<i>xor</i> IO, a	-	-	-	-	<i>xor</i> a, M	Y	-	-	-	<i>xor</i> M, a	Υ	-	-	-
<i>not</i> a	Υ	1	-	-	not M	Υ	1	-	-	<i>neg</i> a	Υ	I	-	I
neg M	Υ	-	-	-	<i>set0</i> IO.n	-	-	-	-	<i>set1</i> IO.n	-	-	-	-
<i>set0</i> M.n	-	-	-	-	<i>set1</i> M.n	-	-	-	-	<i>ceqsn</i> a, l	Υ	Y	Υ	Y
<i>ceqsn</i> a, M	Υ	Y	Y	Y	<i>t0sn</i> IO.n	-	-	-	-	<i>t1sn</i> IO.n	-	-	-	-
<i>t0sn</i> M.n	-	-	-	-	<i>t1sn</i> M.n	-	-	-	-	<i>izsn</i> a	Y	Y	Υ	Y
<i>dzsn</i> a	Υ	Y	Y	Y	izsn M	Y	Y	Υ	Υ	dzsn M	Y	Y	Υ	Y
<i>call</i> label	-	-	-	-	<i>goto</i> label	-	-	-	-	ret I	-	-	-	-
ret	-	-	-	-	reti	•	-	-	-	nop	-	-	-	-
<i>pcadd</i> a	-	-	-	-	engint	-	-	-	-	disgint	-	-	-	-
stopsys	-	-	-	-	stopexe	-	-	-	-	reset	-	-	-	
wdreset	-	I	-	-										

7.9 Summary of affected flags by Instructions

7.10 BIT definition

- (1) Bit defined: Only addressed at $0x00 \sim 0x0F$
- (2) WORD defined : Only addressed at 0x00 ~ 0x1E



8. Code Options

Option	Selection	Description
Coolurity	Enable	Security Enable
Security	Disable	Security Disable
	4.0V	Select LVR = 4.0V
	3.5V	Select LVR = 3.5V
	3.0V	Select LVR = 3.0V
LVR	2.75V	Select LVR = 2.75V
LVK	2.5V	Select LVR = 2.5V
	2.2V	Select LVR = 2.2V
	2.0V	Select LVR = 2.0V
	1.8V	Select LVR = 1.8V
Under 20ms VDD OK	Yes	reach normal operating voltage quickly within 20 mS
Under_20mS_VDD_OK	No	can't reach normal operating voltage quickly within 20 mS
LCD	PB_1256	VDD/2 LCD bias voltage generator enabled, PB[1,2,5,6] are VDD/2 if input mode
(please refer to MISC.4)	PA_1234	VDD/2 LCD bias voltage generator enabled, PA[1,2,3,4] are VDD/2 if input mode



9. Special Notes

This chapter is to remind user who use PMC153/PMS153 series IC in order to avoid frequent errors upon operation.

9.1. Warning

User must read all application notes of the IC by detail before using it. Please download the related application notes from the following link: <u>http://www.padauk.com.tw/tw/technical/index.aspx</u>

9.2. Using IC

9.2.1. IO pin usage and setting

- (1) IO pin as digital input
 - When IO is set as digital input, the level of Vih and Vil would changes with the voltage and temperature. Please follow the minimum value of Vih and the maximum value of Vil.
 - The value of internal pull high resistor would also changes with the voltage, temperature and pin voltage. It is not the fixed value.
- (2) If IO pin is set to be digital input and enable wake-up function
 - Configure IO pin as input
 - Set corresponding bit to "1" in PADIER
- (3) PA5 is set to be output pin
 - PA5 can be set to be Open-Drain output pin only, output high requires adding pull-high resistor.
- (4) PA5 is set to be PRST# input pin
 - No internal pull-high resistor for PA5
 - Configure PA5 as input
 - Set CLKMD.0=1 to enable PA5 as PRST# input pin
- (5) PA5 is set to be input pin and to connect with a push button or a switch by a long wire
 - Needs to put a >10 Ω resistor in between PA5 and the long wire
 - Avoid using PA5 as input in such application.
- (5) PA7 and PA6 as external crystal oscillator
 - Configure PA7 and PA6 as input
 - Disable PA7 and PA6 internal pull-high resistor
 - Configure PADIER register to set PA6 and PA7 as analog input
 - EOSCR register bit [6:5] selects corresponding crystal oscillator frequency :
 - 01 : for lower frequency, ex : 32kHz
 - 10 : for middle frequency, ex : 455kHz、1MHz
 - 11 : for higher frequency, ex : 4MHz
 - Program EOSCR.7 =1 to enable crystal oscillator
 - Ensure EOSC working well before switching from IHRC or ILRC to EOSC



Note: Please read the PMC-APN013 carefully. According to PMC-APN013, the crystal oscillator should be used reasonably. If the following situations happen to cause IC start-up slowly or non-startup, PADAUK Technology is not responsible for this: the quality of the user's crystal oscillator is not good, the usage conditions are unreasonable, the PCB cleaner leakage current, or the PCB layouts are unreasonable.

9.2.2. Interrupt

(1) When using the interrupt function, the procedure should be:

Step1: Set INTEN register, enable the interrupt control bit

Step2: Clear INTRQ register

Step3: In the main program, using ENGINT to enable CPU interrupt function

Step4: Wait for interrupt. When interrupt occurs, enter to Interrupt Service Routine

Step5: After the Interrupt Service Routine being executed, return to the main program

* Use DISGINT in the main program to disable all interrupts

* When interrupt service routine starts, use PUSHAF instruction to save ALU and FLAG register. POPAF instruction is to restore ALU and FLAG register before RETI as below:

void Interrupt (void) // Once the interrupt occurs, jump to interrupt service routine

// enter DISGINT status automatically, no more interrupt is

accepted

{

PUSHAF;

...

POPAF;

- } // RETI will be added automatically. After RETI being executed, ENGINT status will be restored
- (2) INTEN and INTRQ have no initial values. Please set required value before enabling interrupt function

9.2.3. System clock switching

- (1) System clock can be switched by CLKMD register. Please notice that, NEVER switch the system clock and turn off the original clock source at the same time. For example: When switching from clock A to clock B, please switch to clock B first; and after that turn off the clock A oscillator through CLKMD.
 - Case 1 : Switch system clock from ILRC to IHRC/2

CLKMD =	0x36;	// switch to IHRC, ILRC can not be disabled here
CLKMD.2 =	0:	// ILRC can be disabled at this time

• Case 2 : Switch system clock from ILRC to EOSC

CLKMD.2 = 0; // ILRC can be disabled at this time

ERROR. Switch ILRC to IHRC and turn off ILRC simultaneously
 CLKMD = 0x50; // MCU will hang

(2) Please ensure the EOSC oscillation has established before switching from ILRC or IHRC to EOSC. MCU will not check its status. Please wait for a while after enabling EOSC. System clock can be switched to EOSC afterwards. Otherwise, MCU will hang. The example for switching system clock from ILRC to 4MHz EOSC after boot up is as below:



.ADJUST IC DISABLE CLKMD.1 = 0;// turn off WDT for executing delay instruction. \$ EOSCR Enable, 4MHz; // 4MHz EOSC start to oscillate 荡。 // Delay for EOSC establishment \$ T16M EOSC,/1,BIT10 Word Count = 0; Stt16 Count; Intrq.T16 = 0: wait1 Intrq.T16; CLKMD = 0xA4: // ILRC -> EOSC: CLKMD.2 = 0: // turn off ILRC but not necessarily routine

The delay duration should be adjusted in accordance with the characteristic of the crystal and PCB.To measure the oscillator signal by the oscilloscope, please select (x10) on the probe and measure through PA6(X2) pin to avoid the interference on the oscillator.

9.2.4. Power down mode, wakeup and watchdog

- (1) Watchdog will be inactive once ILRC is disabled
- (2) Please turn off watchdog before executing STOPSYS or STOPEXE instruction, otherwise IC will be reset due to watchdog timeout. It is the same as in ICE emulation.
- (3) The clock source of Watchdog is ILRC if the fast wakeup is disabled; otherwise, the clock source of Watchdog will be the system clock and the reset time from watchdog becomes much shorter. It is recommended to disable Watchdog and enable fast wakeup before entering STOPSYS mode. When the system is waken up from power down mode, please firstly disable fast wakeup function, and then enable Watchdog. It is to avoid system to be reset after being waken up.
- (4) If enable Watchdog during programming and also wants the fast wakeup, the example as below:

CLKMD.En_WatchDog // disable watchdog timer = 0: \$ MISC Fast_Wake_Up; stopexe; nop; WT_xx; \$ MISC // Reset Watchdog time to normal wake-up Wdreset: CLKMD.En_WatchDog 1; // enable watchdog timer =

9.2.5. TIMER time out

When select \$ INTEGS BIT_R (default value) and T16M counter BIT8 to generate interrupt, if T16M counts from 0, the first interrupt will occur when the counter reaches to 0x100 (BIT8 from 0 to 1) and the second interrupt will occur when the counter reaches 0x300 (BIT8 from 0 to 1). Therefore, selecting BIT8 as 1 to generate interrupt means that the interrupt occurs every 512 counts. Please notice that if T16M counter is restarted, the next interrupt will occur once Bit8 turns from 0 to 1.

If select \$ INTEGS BIT_F(BIT triggers from 1 to 0) and T16M counter BIT8 to generate interrupt, the T16M counter changes to an interrupt every 0x200/0x400/0x600/. Please pay attention to two differences with setting INTEGS methods.



9.2.6. LVR

- (1) VDD must reach or above 2.0V for successful power-on process; otherwise IC will be inactive.
- (2) The setting of LVR (1.8V, 2.0V, 2.2V etc) will be valid just after successful power-on process.
- (3) User can set EOSCR.0 as "1" to disable LVR. However, VDD must be kept as exceeding the lowest working voltage of chip; Otherwise IC may work abnormally.

9.2.7. IHRC

- (1) The IHRC frequency calibration is performed when IC is programmed by the writer.
- (2) Because the characteristic of the Epoxy Molding Compound (EMC) would some degrees affects the IHRC frequency (either for package or COB), if the calibration is done before molding process, the actual IHRC frequency after molding may be deviated or becomes out of spec. Normally, the frequency is getting slower a bit.
- (3) It usually happens in COB package or Quick Turnover Programming (QTP). And PADAUK would not take any responsibility for this situation.
- (4) Users can make some compensatory adjustments according to their own experiences. For example, users can set IHRC frequency to be 0.5% ~ 1% higher and aim to get better re-targeting after molding.

9.2.8. LCD COM pin application

(1) There are two groups of LCD COM IO selectable for PMC156/PMS156, they are

PA_1234(PA1/COM1,PA2/COM2,PA3/COM3,PA4/COM4) and

PB_1256(PB1/COM0A,PB2/COM1A,PB5/COM2A,PB6/COM3A).

(2) In the practical application, only one group is actually used. User can select one of the groups in Code Option where the LVR value is also selectable before program compiling. The code option is shown as below. Please notice that once the code option is confirmed, any change will be unacceptable in the next programming.

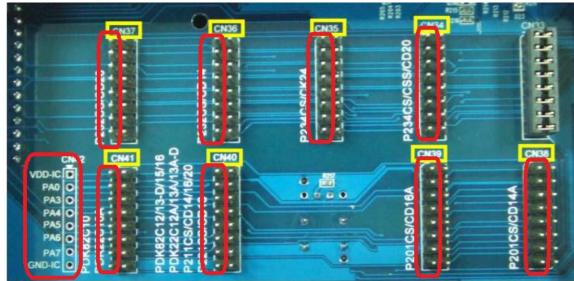
PMC156		
OK Under_20mS_VDD_0k	LVD	Cancel
O No	• 4.0V	C PB_1256
Yes	○ 3.5V	• PA_1234
	○ 3.0V	
Security	C 2.75V	
C Enable	C 2.5V	
Oisable	C 1.8V	
	© 2.2V	
	C 2.0V	



9.2.9. Program writing

There are 6 pins for using the writer to program: PA3, PA4, PA5, PA6, VDD and GND.

Please use PDK3S-P-002 for program real chip and just use the CN40 jumper (at the back for the writer) with putting the PMC156/PMS156- SOP14/16/20 & SOP18/DIP18 IC in the top of the Textool . Other packages could be programmed by connecting the signals correspondingly. All the signals of the left side of the jumpers are the same and as the descriptions at the left bottom corner. They are VDD, PA0(not used), PA3, PA4, PA5, PA6, PA7(not used), and GND).



If user use PDK5S-P-003 or above to program, please follow the instructions for connecting jumpers.

- Special notes about voltage and current while Multi-Chip-Package(MCP) or On-Board Programming
 - (1) PA5 (V_{PP}) may be higher than 11V.
 - (2) V_{DD} may be higher than 6.5V, and its maximum current may reach about 20mA.
 - (3) All other signal pins level (except GND) are the same as V_{DD} .

User should confirm when using this product in MCP or On-Board Programming, the peripheral circuit or components will not be destroyed or limit the above voltages.

9.3. Using ICE

Please use PDK5S-I-S01/2(B) ICE to emulate PMC156/PMS156. Please note in the simulation:

- PDK5S-I-S01/2(B) doesn't support the instruction NMOV/SWAP/NADD/COMP with RAM
- PDK5S-I-S01/2(B) doesn't support the dynamic setting of function *misc.4* (Only fix to 0 or 1)
- Fast Wakeup time is different from PDK5S-I-S01/2(B): 128 SYSCLK, PMC156/PMS156: refer to 5.8.3
- Watch dog time out period is different from PDK5S-I-S01/2(B):

WDT period	PDK5S-I-S01/2 (B)	PMC156/PMS156
misc[1:0]=00	2048 * T _{ILRC}	8K * T _{ILRC}
misc[1:0]=01	4096 * T _{ILRC}	16K * T _{ILRC}
misc[1:0]=10	16384 * T _{ILRC}	64K * T _{ILRC}
misc[1:0]=11	256 * T _{ILRC}	256K * T _{ILRC}